ACADEMIC REGULATIONS, COURSE STRUCTURE

AND DETAILED SYLLABUS
UNDER

CHOICE BASED CREDIT SYSTEM (CBCS)

Effective from the Academic Year 2015-16

M. Tech. Two Year Degree Course

(MR-15 Regulations)

in

DIGITAL SYSTEMS & COMPUTER ELECTRONICS (DSCE)

Department of Electronics & Communication Engineering

MALLA REDDY ENGINEERING COLLEGE (Autonomous)

(An Autonomous Institution approved by UGC and affiliated to JNTUH, Approved by AICTE & Accredited by NAAC with 'A' Grade and NBA & Recipient of World Bank Assistance under TEQIP Phase – II, S.C 1.1)

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MALLA REDDY ENGINEERING COLLEGE (AUTONOMOUS)

MR 15– ACADEMIC REGULATIONS (CBCS) FOR M. Tech. (REGULAR) DEGREE PROGRAMME

Applicable for the students of M. Tech. (Regular) programme from the Academic Year ***2015-16*** and onwards.

The M. Tech. Degree of Jawaharlal Nehru Technological University Hyderabad shall be conferred on candidates who are admitted to the programme and who fulfill all the requirements for the award of the Degree.

INSTITUTION VISION

A Culture of excellence , the hallmark of MREC as world class education center to impart Technical Knowledge in an ambience of humanity, wisdom, intellect, creativity with ground breaking discovery, in order to nurture the students to become Globally competent committed professionals with high discipline, compassion and ethical values.

INSTITUTION MISSION

Commitment to progress in mining new knowledge by adopting cutting edge technology to promote academic growth by offering state of art Under graduate and Post graduate programmes based on well-versed perceptions of Global areas of specialization to serve the Nation with Advanced Technical knowledge.

DEPARTMENT VISION

With a vision to develop innovative, globally competent and quality electronic engineers by imparting state of art technology to foster a climate of high professionalism, ethical values, excellence and devotion.

DEPARTMENT MISSION

- To enrich the knowledge of students through quality and value based education.
- To organize various effective training programs in order to compete the advanced technology.
- To produce employable under graduates and post graduates.

PROGRAMME EDUCATIONAL OBJECTIVES (PEOs)

PEO1: To provide the post graduate students with an advanced technical knowledge in the areas of Digital Systems and Computer Electronics, so as to make them to design, analyze and create the product relevant to the course.

PEO2: To train the PG students in the field of Digital Systems and Computer Electronics and make themselves as Research & Development engineers, industry ready with a focus on effective communication skills, team working and multidisciplinary approach.

PEO3: To continue in inducing & Practicing professional ethics, honest practices to make them responsible towards the society collectively.

PROGRAMME OUTCOMES (POs)

PO1: PG students acquired specialized and in depth knowledge in the areas of Digital Systems and Computer Electronics.

PO2: PG Students can demonstrate their ability in analyzing the complex and critical engineering problems in their field, apart from solving the subject problems.

PO3: PG Students can demonstrate their ability to think and work independently, with minimum or no supervision, and able to provide various solutions, by due considering the importance level of the technical requirement and associated issues.

PO4: PG Students can have the opportunity of working in Research & Development environment, in government organizations, and also able to develop intellectual property, patents etc.,

PO5: PG Students can have the opportunity to work in various industry standard tools like, MATLAB, Cadence, Xilinx, Altera, MicroWind and Microsoft Visual C++ 6.0 etc, which enables them industry ready, which in turn opens up and enhances the career opportunities.

PO6: PG Students can become, entrepreneurs, transforming their ideas into a product and systems to benefit the society, and empower themselves socially responsible.

PO7: PG Students are capable enough to write the technical reports, specifications and documenting the standards, which was imparted to them through training on communication skills, particularly verbal and written.

PO8: PG Students can work in multi cultural environment using their communication skills, and builds the interpersonal relationship in a team environment, capable of managing the team to achieve the goal of the project, and support the business and service motives of the organization.

PO9: PG Students can opt for higher education, particularly research in the field of Digital Systems & Computer Electronics. Update the technical knowledge by involving in continuous learning process, being a member of profession body through research publications and in turn contribute back to the technical community.

PO10: Students can apply ethical and honest practices, to commit to the professional ethics expected from them and responsible towards the society.

PO11: Students can understand the impact of electronics products on to the global environmental perspective and demonstrate their skills and knowledge for sustained development.

1.0 ELIGIBILITY FOR ADMISSIONS :

Admission to the above programme shall be made subject to eligibility, qualification and specialization as prescribed by the University from time to time.
Admissions shall be made on the basis of merit/rank obtained by the candidates at the qualifying Entrance Test conducted by the Government of Telangana or on the basis of any other order of merit as approved by the University, subject to reservations as laid down by the Govt. from time to time.

2.0 AWARD OF M.Tech. DEGREE :

2.1 A student shall be declared eligible for the award of the M.Tech. Degree, if the student pursues a course of study in not less than two and not more than four academic years. However, the student is permitted to write the examinations for two more years after four academic years of course work, failing which the student shall forfeit the seat in M. Tech. programme.

2.2 The student shall register for all 88 credits and secure all the 88 credits.

2.3 The minimum instruction days in each semester are 90.

3.0 COURSES OF STUDY :

The following specializations are offered at present for the M. Tech. programme of study.

1. Computer Science and Engineering
2. Digital Systems and Computer Electronics
3. Electrical Power Systems
4. Embedded Systems
5. Geotechnical Engineering
6. Machine Design
7. Structural Engineering
8. Thermal Engineering
9. VLSI System Design

and any other programme as approved by the University from time to time.

3.1 Departments offering M. Tech. Programmes with specializations are noted below:

CE	GTE	Geo Technical Engineering
	SE	Structural Engineering
EEE	EPS	Electrical Power Systems
ME	MD	Machine Design
	TE	Thermal Engineering
ECE	DSCE	Digital Systems and Computer Electronics
	ES	Embedded Systems
	VLSI SD	VLSI System Design
CSE	CSE	Computer Science and Engineering

4 COURSE REGISTRATION :

4.1 A 'Faculty Advisor or Counselor' shall be assigned to each student, who will advise him on the Post Graduate Programme (PGP), its Course Structure and Curriculum, Choice/Option for Subjects/ Courses, based on his competence, progress, pre-requisites and interest.

4.2 Academic Section of the College invites 'Registration Forms' from students within 15 days from the commencement of class work for the first semester through 'ON-LINE SUBMISSIONS', ensuring 'DATE and TIME Stamping'. The ON-LINE Registration Requests for any 'SUBSEQUENT SEMESTER' shall be completed BEFORE the commencement of SEEs (Semester End Examinations) of the 'CURRENT SEMESTER'.

4.3 A Student can apply for ON-LINE Registration, ONLY AFTER obtaining the 'WRITTEN APPROVAL' from the Faculty Advisor, which should be submitted to the College Academic Section through the Head of Department (a copy of it being retained with Head of Department, Faculty Advisor and the Student).

4.4 If the Student submits ambiguous choices or multiple options or erroneous entries during ON-LINE Registration for the Subject(s) / Course(s) under a given/ specified Course Group/ Category as listed in the Course Structure, only the first mentioned Subject/ Course in that Category will be taken into consideration.

4.5 Subject/ Course Options exercised through ON-LINE Registration are final and CANNOT be changed, nor can they be inter-changed; further, alternate choices will also not be considered. However, if the Subject/ Course that has already been listed for Registration (by the Head of Department) in a Semester could not be offered due to any unforeseen or unexpected reasons, then the Student shall be allowed to have alternate choice - either for a new Subject (subject to offering of such a Subject), or for another existing Subject (subject to availability of seats), which may be considered. Such alternate arrangements will be made by the Head of Department, with due notification and time-framed schedule, within the FIRST WEEK from the commencement of Class-work for that Semester.

5 ATTENDANCE :

The programmes are offered on a unit basis with each subject/course being considered as a unit.

5.1 Attendance in all classes (Lectures/Laboratories etc.) is compulsory. The minimum required attendance in each theory / Laboratory etc. is 75% including the days of attendance in sports, games, NCC and NSS activities for appearing for the Semester End examination (SEE). A student shall not be permitted to appear for the Semester End Examinations (SEE) if his attendance is less than 75%.

5.2 Condonation of shortage of attendance in each subject up to 10% (65% and above and below 75%) in each semester shall be granted by the College Academic Committee (CAC).

5.3 Shortage of Attendance below 65% in each subject shall not be condoned.

5.4 Students whose shortage of attendance is not condoned in any subject are not eligible to write their end Semester End Examination of that subject and their registration shall stand cancelled.

5.5 A fee prescribed by the CAC, shall be payable towards Condonation of shortage of attendance.

5.6 A Candidate shall put in a minimum required attendance in atleast three (3) theory subjects in I semester for promoting to II Semester. In order to qualify for the award of the M.Tech. Degree, the candidate shall complete all the academic requirements of the subjects, as per the course structure.

5.7 A student shall not be promoted to the next semester unless the student satisfies the attendance requirement of the present Semester, as applicable. The student may seek readmission into that semester when offered next. If any candidate fulfills the attendance requirement in the present semester, the student shall not be eligible for readmission into the same class.

6 EVALUATION - DISTRIBUTION AND WEIGHTAGE OF MARKS: :

The performance of the candidate in each semester shall be evaluated subject-wise, with a maximum of 100 marks for theory and 100 marks for practicals, on the basis of Continuous Internal Evaluation and Semester End Examinations. For all Subjects/ Courses, the distribution shall be 40 marks for CIE, and 60 marks for the SEE

6.1 Theory Courses :

6.1.1 Continuous Internal Evaluation (CIE):

The CIE consists of two Assignments each of 05 marks and two mid-term examinations each of 35 marks. The CIE shall be finalized based on the 70% of the best performed and 30% of the other performance.The first mid-term examination shall be conducted for the first 50% of the syllabus, and the second mid-term examination shall be conducted for the remaining 50% of the syllabus.

First Assignment should be submitted before the conduct of the first mid-term examinations, and the Second Assignment should be submitted before the conduct of the second midterm examinations. The Assignments shall be as specified by the concerned subject teacher.. Each mid-term examination shall be conducted for a total duration of 120 minutes, for 35 marks.

The division of marks for CIE is as given below:

Mid – Term Examination				
Part	**Type of Questions**	**No. of questions**	**Marks per question**	**Total**
Part A	Multiple-choice questions	10	0.5	05
	Fill-in the blanks	10	0.5	05
	Sub-Total			10
Part B	Compulsory questions	5	2	10
Part C	Choice questions (3 out of 5)	3	5	15
			Mid-Term Exam Total	35
			Assignment	05
			Grand Total	40

6.1.2 Semester End Examination (SEE):

The division of marks for SEE is as given below:

Semester End Examination				
Part	**Type of Questions**	**No. of questions to be answered**	**Marks per question**	**Total**
Part A	Compulsory Questions (One from each module)	5	4	20
Part B	Choice Questions (5 out of 8) (Minimum one from each module)	5	8	40
			Grand Total	60

6.2 Practical Courses:

6.2.1 Continuous Internal Evaluation (CIE):

There will be CIE for 40 marks, shall be awarded with a distribution of 20 marks for day-to-day performance and timely submission of lab records, 5 marks for viva-voce, 15 marks for internal lab exam (best out of two exams).

6.2.2 Semester End Examination (SEE):

There will be SEE for 60 marks, shall be awarded with a distribution of 20 marks for write-up on the given experiment, 20 marks for proficiency in the exam, 10 marks for results and 10 marks for viva-voce. For conducting SEE, one internal examiner and one external examiner will be appointed by the Chief Controller of Examinations of the College. The external examiner should be selected from outside the College among the autonomous/reputed institutions, from a panel of three examiners submitted by the concerned Head of the Department.

6.3 Seminar:

There shall be two seminar presentations during I semester and II semester. For seminar, a student under the supervision of a faculty member, shall collect the literature on a topic and critically review the literature and submit it to the department in a report form and shall make an oral presentation before the Departmental Academic Committee consisting of Head of the Department, Supervisor and two other senior faculty members of the department. For each Seminar there will be only internal evaluation of 100 marks with a distribution of 30 marks for the report, 50 marks for presentation and 20 marks for the queries. A candidate has to secure a minimum of 50% of marks to be declared successful. If the student fails to fulfill minimum marks, the student has to reappear during the supplementary examinations.

6.4 Comprehensive Viva-Voce:

There shall be a Comprehensive Viva-Voce in III Semester. The Comprehensive Viva-Voce is intended to assess the students' understanding

of various subjects studied during the M. Tech. course of study. The Head of the Department shall be associated with the conduct of the Comprehensive Viva-Voce through a Committee. The Committee consists of the Head of the Department, one senior faculty member and an external examiner. The external examiner shall be appointed by the Chief Controller of Examinations from a panel of three examiners submitted by the concerned Head of the Department. There are no internal marks for the Comprehensive Viva-Voce and evaluates for maximum of 100 marks. A candidate has to secure a minimum of 50% of marks to be declared successful. If the student fails to fulfill minimum marks, the student has to reappear during the supplementary examinations.

6.5. **General:** A candidate shall be deemed to have secured the minimum academic requirement in a subject if he secures a minimum of 40% of marks in the Semester End Examination and a minimum of 50% of the total marks in the Semester End Examination and Continuous Internal Evaluation taken together. In case the candidate does not secure the minimum academic requirement in any subject he has to reappear for the Semester End Examination in that subject. A candidate shall be given one chance to re-register for the subject if the internal marks secured by the candidate are less than 50% and failed in that subject. This is allowed for a maximum of three subjects and should register within two weeks of commencement of that semester class work. In such a case, the candidate must re-register for the subjects and secure the required minimum attendance. The candidate's attendance in the re-registered subject(s) shall be calculated separately to decide upon the eligibility for writing the Semester End Examination in those subjects. In the event of the student taking another chance, the student's Continuous Internal Evaluation (CIE) marks and Semester End Examination (SEE) marks obtained in the previous attempt stands cancelled.

7 EXAMINATIONS AND ASSESSMENT - THE GRADING SYSTEM :

7.1 Marks will be awarded to indicate the performance of each student in each Theory Subject, or Lab / Practicals, or Seminar, or Project, etc., based on the % marks obtained in CIE + SEE (Continuous Internal Evaluation + Semester End Examination, both taken together) as specified in Item 6 above, and a corresponding Letter Grade shall be given.

7.2 As a measure of the student's performance, a 10-point Absolute Grading System using the following Letter Grades (UGC Guidelines) and corresponding percentage of marks shall be followed:

% of Marks Secured (Class Intervals)	Grade Points	Letter Grade (UGC Guidelines)
≥ 80%	10	O (Outstanding)
≥ 70% to < 80%	9	A+ (Excellent)
≥ 60% to < 70%	8	A (Very Good)
≥ 55% to < 60%	7	B+ (Good)
≥ 50% to < 55%	6	B (Above Average)
< 50%	0	F (Fail)
Absent	Ab	Ab

7.3 A student obtaining F Grade in any Subject shall be considered 'failed' and is be required to reappear as 'Supplementary Candidate' in the Semester End Examination (SEE), as and when conducted. In such cases, his Internal Marks (CIE Marks) in those Subjects will remain the same as those he obtained earlier.

7.4 A student not appeared for examination then 'Ab' Grade will be allocated in any Subject shall be considered 'failed' and will be required to reappear as 'Supplementary Candidate' in the Semester End Examination (SEE), as and when conducted.

7.5 A Letter Grade does not imply any specific Marks percentage and it will be the range of marks percentage.

7.6 In general, a student shall not be permitted to repeat any Subject/ Course (s) only for the sake of 'Grade Improvement' or 'SGPA/ CGPA Improvement'.

7.7 A student earns Grade Point (GP) in each Subject/ Course, on the basis of the Letter Grade obtained by him in that Subject/ Course. The corresponding 'Credit Points' (CP) is computed by multiplying the Grade Point with Credits for that particular Subject/ Course.
Credit Points (CP) = Grade Point (GP) x Credits …. For a Course

7.8 The Student passes the Subject/ Course only when he gets GP $\geq$ 6(B Grade or above).

7.9 The Semester Grade Point Average (SGPA) is calculated by dividing the Sum of Credit Points ($\sum$CP) secured from ALL Subjects/ Courses registered in a Semester, by the Total Number of Credits registered during that Semester. SGPA is rounded off to TWO Decimal Places. SGPA is thus computed as:

$$\text{SGPA} = \left\{\sum_{i=1}^{N} C_i G_i\right\} / \left\{\sum_{i=1}^{N} C_i\right\} \ldots \text{For each Semester}$$

where 'i' is the Subject indicator index (takes into account all Subjects in a Semester), 'N'is the no. of Subjects 'REGISTERED' for the Semester (as specifically required and listed under the Course Structure of the parent Department), C_i is the no. of Credits allotted to the i^{th} Subject, and G represents the Grade Points (GP) corresponding to the Letter Grade awarded for that i^{th} Subject.

7.10 The Cumulative Grade Point Average (CGPA) is a measure of the overall cumulative performance of a student over all Semesters considered for registration. The CGPA is the ratio of the Total Credit Points secured by a student in ALL registered Courses in ALL Semesters, and the Total Number of Credits registered in ALL the Semesters. CGPA is rounded off to TWO Decimal Places. CGPA is thus computed from the II Semester onwards, at the end of each Semester, as per the formula

$$\text{CGPA} = \left\{\sum_{j=1}^{M} C_j G_j\right\} / \left\{\sum_{j=1}^{M} C_j\right\} \ldots \text{for all S semesters registered}$$
(i.e., upto and inclusive of S semesters, S $\geq$ 2)

where 'M' is the TOTAL no. of Subjects (as specifically required and listed under the Course Structure of the parent Department) the Student has 'REGISTERED' from the 1stSemester onwards upto and inclusive of the

Semester S (obviously M > N), 'j' is the Subject indicator index (takes into account all Subjects from 1 to S Semesters), C_j is the no. of Credits allotted to the j^{th} Subject, and G_j represents the Grade Points (GP)corresponding to the Letter Grade awarded for that j^{th} Subject. After registration and completion of I Semester however, the SGPA of that Semester itself may be taken as the CGPA, as there are no cumulative effects.

7.11 For Calculations listed in Item 7.6 – 7.10, performance in failed Subjects/ Courses (securing F Grade) will also be taken into account, and the Credits of such Subjects/Courses will also be included in the multiplications and summations.

8. EVALUATION OF PROJECT/DISSERTATION WORK :

Every candidate shall be required to submit a thesis or dissertation on a topic approved by the Project Review Committee.

8.1 A Project Review Committee (PRC) shall be constituted with Head of the Department as Chairperson, Project Supervisor and one senior faculty member of the Departments offering the M. Tech. programme.

8.2 Registration of Project Work: A candidate is permitted to register for the project work after satisfying the attendance requirement of all the subjects, both theory and practical.

8.3 After satisfying 8.2, a candidate has to submit, in consultation with his Project Supervisor, the title, objective and plan of action of his project work to the PRC for approval. Only after obtaining the approval of the PRC the student can initiate the Project work.

8.4 If a candidate wishes to change his supervisor or topic of the project, he can do so with the approval of the PRC. However, the PRC shall examine whether or not the change of topic/supervisor leads to a major change of his initial plans of project proposal. If yes, his date of registration for the project work starts from the date of change of Supervisor or topic as the case may be.

8.5 A candidate shall submit his project status report in two stages at least with a gap of 3 months between them.

8.6 The work on the project shall be initiated at the beginning of the III Semester and the duration of the project is two semesters. A candidate is permitted to submit Project Thesis only after successful completion of all theory and practical courses with the approval of PRC not earlier than 40 weeks from the date of registration of the project work. For the approval of PRC the candidate shall submit the draft copy of thesis to the Head of the Department and make an oral presentation before the PRC.
Note: *The project supervisor/guide has to ensure that the student has to publish a minimum of one paper related to the thesis in a National/International Conference/Journal.*

8.7 For the final approval by the PRC, the soft copy of the thesis should be submitted for ANTI-PLAGIARISM for the quality check and the plagiarism report should be included in the final thesis. If the copied information is less than 24%, then only thesis will be accepted for submission.

8.8 Three copies of the Project Thesis certified by the supervisor, HOD and Principal shall be submitted to the Chief Controller of Examinations for project evaluation (viva voce).

8.9 For Project work part-I in III Semester there is an internal marks of 50, the evaluation should be done by the PRC for 30 marks and Supervisor will evaluate for 20 marks. The Supervisor and PRC will examine the Problem Definition, Objectives, Scope of Work, Literature Survey in the same domain. A candidate has to secure a minimum of 50% of marks to be declared successful for Project work part-I. If the student fails to fulfill minimum marks, the student has to reappear during the supplementary examination.

8.10 For Project work part-II in IV Semester there is an internal marks of 50, the evaluation should be done by the PRC for 30 marks and Supervisor will evaluate for 20 marks. The PRC will examine the overall progress of the Project Work and decide the Project is eligible for final submission or not. A candidate has to secure a minimum of 50% of marks to be declared successful for Project work part-II. If the student fails to fulfill minimum marks, the student has to reappear during the supplementary examination.

8.11 For Project Evaluation (Viva Voce) in IV Semester there is an external marks of 150 and the same evaluated by the External examiner appointed by the Chief Controller of Examinations. For this, the Head of the Department shall submit a panel of 3 examiners, eminent in that field, with the help of the supervisor/guide concerned. The candidate has to secure minimum of 50% marks in Project Evaluation (Viva-Voce) examination.

8.12 If the student fails to fulfill as specified in 8.11, based the recommendation of the external examiner, the student will reappear for the Viva-Voce examination with the revised thesis only after three months. In the reappeared examination also, fails to fulfill, the student will not be eligible for the award of the degree.

8.13 The Head of the Department shall coordinate and make arrangements for the conduct of Project Viva-Voce examination.

9. AWARD OF DEGREE AND CLASS :

9.1 A Student who registers for all the specified Subjects/ Courses as listed in the Course Structure, satisfies all the Course Requirements, and passes the examinations prescribed in the entire PG Programme (PGP), and secures the required number of **88** Credits (with CGPA $\geq$ 6.0), shall be declared to have 'QUALIFIED' for the award of the M.Tech. Degree in the chosen Branch of Engineering and Technology with specialization as he admitted.

9.2 Award of Class

After a student has satisfied the requirements prescribed for the completion of the programme and is eligible for the award of M. Tech. Degree, he shall be placed in one of the following three classes based on the CGPA:

Class Awarded	CGPA
First Class with Distinction	≥ 7.75
First Class	≥ 6.75 and < 7.75
Second Class	≥ 6.00 and < 6.75

9.3 A student with final CGPA (at the end of the PGP) < 6.00 will not be eligible for the Award of Degree.

10. WITHHOLDING OF RESULTS :

If the student has not paid the dues, if any, to the University or if any case of indiscipline is pending against him, the result of the student will be withheld and he will not be allowed into the next semester. His degree will be withheld in such cases.

11. TRANSITORY REGULATIONS :

11.1 If any candidate is detained due to shortage of attendance in one or more subjects, they are eligible for re-registration to maximum of three earlier or equivalent subjects at a time as and when offered.

11.2 The candidate who fails in any subject will be given two chances to pass the same subject; otherwise, he has to identify an equivalent subject as per MR15 Academic Regulations.

12. GENERAL :

12.1 **Credit**: A unit by which the course work is measured. It determines the number of hours of instructions required per week. One credit is equivalent to one hour of teaching (lecture or tutorial) or two hours of practical work/field work per week.

12.2 **Credit Point:** It is the product of grade point and number of credits for a course.

12.3 Wherever the words “he”, “him”, “his”, occur in the regulations, they include “she”, “her”.

12.4 The academic regulation should be read as a whole for the purpose of any interpretation.

12.5 In the case of any doubt or ambiguity in the interpretation of the above rules, the decision of the CAC is final.

MALPRACTICES RULES

DISCIPLINARY ACTION FOR / IMPROPER CONDUCT IN EXAMINATIONS

	Nature of Malpractices/Improper conduct	**Punishment**
	If the candidate:	
1. (a)	Possesses or keeps accessible in examination hall, any paper, note book, programmable calculators, Cell phones, pager, palm computers or any other form of material concerned with or related to the subject of the examination (theory or practical) in which he is appearing but has not made use of (material shall include any marks on the body of the candidate which can be used as an aid in the SEE)	Expulsion from the examination hall and cancellation of the performance in that course only.
(b)	Gives assistance or guidance or receives it from any other candidate orally or by any other body language methods or communicates through cell phones with any candidate or persons in or outside the exam hall in respect of any matter.	Expulsion from the examination hall and cancellation of the performance in that course only of all the candidates involved. In case of an outsider, he will be handed over to the police and a case is registered against him.
2	Has copied in the examination hall from any paper, book, programmable calculators, palm computers or any other form of material relevant to that course of the examination (theory or practical) in which the candidate is appearing.	Expulsion from the examination hall and cancellation of the performance in that course and all other courses the candidate has already appeared including practical examinations and project work and shall not be permitted to appear for the remaining examinations of the courses of that Semester. The Hall Ticket of the candidate shall be cancelled.
3	Impersonates any other candidate in connection with the examination.	The candidate who has impersonated shall be expelled from examination hall. The candidate is also debarred and forfeits the seat. The performance of the original candidate who has been impersonated, shall be cancelled in all the courses of the examination (including practicals and project

		work) already appeared and shall not be allowed to appear for examinations of the remaining courses of that semester. The candidate is also debarred for two consecutive semesters from class work and all SEE. The continuation of the programme by the candidate is subject to the academic regulations in connection with forfeiture of seat. If the imposter is an outsider, he will be handed over to the police and a case is registered against him.
4	Smuggles in the Answer book or additional sheet or takes out or arranges to send out the question paper during the examination or answer book or additional sheet, during or after the examination.	Expulsion from the examination hall and cancellation of performance in that course and all the other courses the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the courses of that semester. The candidate is also debarred for two consecutive semesters from class work and all SEE. The continuation of the programme by the candidate is subject to the academic regulations in connection with forfeiture of seat.
5	Uses objectionable, abusive or offensive language in the answer paper or in letters to the examiners or writes to the examiner requesting him to award pass marks.	Cancellation of the performance in that course.
6	Refuses to obey the orders of the Chief Controller of Examinations (CCE) / Controller of Examinations (CE) / Assistant Controller of Examinations (ACE) / any officer on duty or misbehaves or creates disturbance of any kind in and around the examination hall or organizes a walk out or instigates others to walk out, or threatens the officer-in charge or any person on duty in or outside the examination hall of any injury to his person or to any of his relations whether by words, either spoken or written or by signs or by visible representation, assaults	In case of students of the college, they shall be expelled from examination halls and cancellation of their performance in that course and all other courses the candidate(s) has (have) already appeared and shall not be permitted to appear for the remaining examinations of the courses of that semester. The candidates also are debarred and forfeit their seats. In case of outsiders, they will be handed over to the police and a

	the officer in-charge, or any person on duty in or outside the examination hall or any of his relations, or indulges in any other act of misconduct or mischief which result in damage to or destruction of property in the examination hall or any part of the College campus or engages in any other act which in the opinion of the officer on duty amounts to use of unfair means or misconduct or has the tendency to disrupt the orderly conduct of the examination	police cases registered against them.
7	Leaves the exam hall taking away answer script or intentionally tears of the script or any part thereof inside or outside the examination hall.	Expulsion from the examination hall and cancellation of performance in that course and all the other courses the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the courses of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all SEE. The continuation of the programme by the candidate is subject to the academic regulations in connection with forfeiture of seat.
8	Possess any lethal weapon or firearm in the examination hall.	Expulsion from the examination hall and cancellation of the performance in that course and all other courses the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the courses of that semester. The candidate is also debarred and forfeits the seat.
9	If student of the college, who is not a candidate for the particular examination or any person not connected with the college indulges in any malpractice or improper conduct mentioned in clause 6 to 8.	Expulsion from the examination hall and cancellation of the performance in that course and all other courses the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the courses of that semester. The candidate is also debarred and forfeits the seat.

		Person(s) who do not belong to the College will be handed over to police and, a police case will be registered against them.
10	Comes in a drunken condition to the examination hall.	Expulsion from the examination hall and cancellation of the performance in that course and all other courses the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the courses of that semester.
11	Copying detected on the basis of internal evidence, such as, during valuation or during special scrutiny.	Cancellation of the performance in that course and all other courses the candidate has appeared including practical examinations and project work of that SEE.
12	If any malpractice is detected which is not covered in the above clauses 1 to 11 shall be reported to the CCE for further action toward suitable punishment.	

Note: ***The student(s) found indulging in malpractices during the CIE also will be punished based on the recommendations of the College Academic Committee.***

MALLA REDDY ENGINEERING COLLEGE (Autonomous)

Academic Year 2015-16 (Choice Based Credit System)

COURSE STRUCTURE – M.TECH Digital System and Computer Electronics (DSCE)

(MR15 Regulations)

I SEMESTER

S. No.	Category	Course Code	Name of the course	Contact hours/ week			Credits	Scheme of Valuation		Total Marks
				L	T	P		Internal (CIE)	External (SEE)	
1	CC I	54101	VLSI Technology and Design	4	--	--	4	40	60	100
2	CC II	54102	Digital System Design	4	--	--	4	40	60	100
3	CC III	54103	Advanced Data Communications	4	--	--	4	40	60	100
4	PE I	54104	Hardware and Software Co-Design	4	--	--	4	40	60	100
		54105	Image and Video Processing							
		54106	Embedded System Design							
5	PE II	54107	CMOS Digital Integrated Circuit Design	4	--	--	4	40	60	100
		54108	Internetworking							
		54109	Design of Fault Tolerant Systems							
6	PE III	54110	Coding Theory and Techniques	4	--	--	4	40	60	100
		54111	Soft Computing Techniques							
		54112	Nano Electronics							
7	Laboratory I	54113	VLSI Lab	--	--	4	2	40	60	100
8	Seminar I	54114	Seminar - I	--	--	4	2	100	--	100
Total				24	--	8	28	Contact Periods: 32		

II SEMESTER

S. No.	Category	Course Code	Name of the course	Contact hours/week			Credits	Scheme of Valuation		Total Marks
				L	T	P		Internal (CIE)	External (SEE)	
1	CC IV	55134	Advanced Computer Architecture	4	--	--	4	40	60	100
2	CC V	54115	Digital Signal Processors and Architectures	4	--	--	4	40	60	100
3	CC VI	54116	Real Time Operating Systems	4	--	--	4	40	60	100
4	PE IV	54117	CPLD and FPGA Architectures and Applications	4	--	--	4	40	60	100
		54118	Network Security and Cryptography							
		54119	System on Chip Architecture							
5	PE V	54120	Low Power VLSI Design	4	--	--	4	40	60	100
		54121	Design for Testability							
		54122	Device Modeling							
6	PE VI	54123	Software Defined Radio	4	--	--	4	40	60	100
		54124	Ad hoc Wireless Networks							
		54125	Scripting Languages							
7	Laboratory II	54126	Embedded System Lab	--	--	4	2	40	60	100
8	Seminar II	54127	Seminar - II	--	--	4	2	100	--	100
Total				24	--	8	28	Contact Periods: 32		

III Semester

S. No.	Category	Course Code	Name of the course	Contact hours/week			Credits	Scheme of Valuation		Total Marks
				L	T	P		Internal (CIE)	External (SEE)	
1	CV	54128	Comprehensive Viva-Voce	-	-	-	4	-	100	100
2	PR I	54129	Project work Part I	-	-	16	8	50	-	50
Total				-	-	16	12	Contact Periods: 16		

IV Semester

S. No.	Category	Course Code	Name of the course	Contact hours/week			Credits	Scheme of Valuation		Total Marks
				L	T	P		Internal (CIE)	External (SEE)	
1	PR II	54130	Project work Part II	-	-	16	8	50	--	50
2	PR III	54131	Project Viva-Voce	-	-	-	12	--	150	150
Total				-	-	16	20	Contact Periods: 16		

*** CC – Core Course, PE – Professional Elective, CV – Comprehensive Viva – Voce, PR – Project Work**

Malla Reddy Engineering College (Autonomous)

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Course Code: 54101 **Credits: 4**

M.Tech. – I Semester

VLSI TECHNOLOGY AND DESIGN

PREREQUISITES: STLD and IC Technology

OBJECTIVE: To Understand the VLSI technology and design of circuits based on technology like cmos, bicmos etc, to Understand the designing layouts of logic gates, to understanding the combinational logic networks and its optimization , to understanding the sequential systems and its optimization, to get knowledge on floor plan design

Module –I **[10 Periods]**

Crystal Growth and Wafer Preparation: Introduction, Electronic-Grade Silicon, Czochralski Crystal Growing, Silicon Shaping, Process Considerations.

Epitaxy: Introduction, Vapour-Phase Epitaxy, Molecular Beam Epitaxy, Silicon on Insulators, Epitaxial Evaluation.

Oxidation : Thin Oxides, Oxidation Techniques and Systems, Oxide properties, Redistribution of Dopant At interface, Oxidation of Poly Silicon, Oxidation inducted Defects

Module –II **[9 Periods]**

Lithography: Introduction, Optical Lithography, Electron Lithography, X-ray Lithography, Ion Lithography.

Reactive Plasma Etching: Introduction, Plasma Properties, Feature-Size Control and Anisotropic Etch Mechanisms, Other Properties of Etch Processes, Reactive Plasma-Etching Techniques and Equipment, Specific Etch Processes.

Module –III **[8 Periods]**

Dielectric and Polysilicon Film Deposition: Introduction, Deposition Processes, Polysilicon, Silicon Dioxide, Silicon Nitride, Plasma Assisted Depositions, Other Materials.

Diffusion: Models of Diffusion in Solids, Flick's one Dimensional Diffusion Equation – Atomic Diffusion Mechanism – Measurement techniques

Module -IV **[9 Periods]**

Ion Implantation: Introduction, Range Theory, Implantation Equipment, Annealing, Shallow Junctions, High-Energy Implantation.

Metallization: Introduction, Metallization Applications, Metallization Choices, Physical Vapor Deposition, Patterning, Metallization Problems..

Module -V **[8 Periods]**

MOS Technology: NMOS, PMOS, CMOS, BICMOS, Latch up,

Basic Electrical Properties of MOS and BICMOS circuits : I_{ds}-V_{ds} relationships, MOS transistor threshold Voltage(Vt), Pass transistor, NMOS Inverter, Determination of pull-up to pull-down ratios, Various pull ups of MOS and BICMOS inverter, Lambda based Design Rules

Text Books:

1. S. M. Sze, "**VLSI Technology**", McGraw-Hill, Second Edition,2003,TMH NewDelhi.
2. Kamran Eshraghian, Eshraghian Dougles and A. Pucknell, **Essentials of VLSI circuits and systems** –2005, PHI New Delhi.

Reference Books:

1. S.K. Ghandhi, "**VLSI Fabrication Principles**", John Wiley Inc., Second Edition New York, 1994.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Student will be in a position that he/she can design vlsi circuits starting from pmos nmos, cmos, and bicmos technology based design
2. Gains thorough knowledge on design tools to draw layouts for the transistor structures
3. The student will understand the design of logic gates
4. The student will understand the design of sequential systems

2015-16

Malla Reddy Engineering College (Autonomous)

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Course Code: 54102 **Credits: 4**

M.Tech. – I Semester

DIGITAL SYSTEM DESIGN

PREREQUISITES: VLSI and STLD

OBJECTIVE: To impart knowledge on the theory of Sequential machines and minimization of it. to design digital circuits for various applications. to learn fault diagnosis and testability algorithms.

MODULE – I :Minimization And Transformation Of Sequential Machines [8 Periods]

The Finite State Model – Capabilities and limitations of FSM – State equivalence and machine minimization – Simplification of incompletely specified machines.
Fundamental mode model – Flow table – State reduction – Minimal closed covers – Races, Cycles and Hazards.

MODULE – II : Digital Design [9 Periods]

Digital Design Using ROMs, PALs and PLAs , BCD Adder, 32 – bit adder, State graphs for control circuits, Scoreboard and Controller, A shift and add multiplier, Array multiplier, Keypad Scanner, Binary divider.

MODULE – III : SM Charts [7 Periods]

State machine charts, Derivation of SM Charts, Realization of SM Chart, Implementation of Binary Multiplier, dice game controller.

MODULE – IV: Fault Modeling & Test Pattern Generation [8 Periods]

Logic Fault model – Fault detection & Redundancy- Fault equivalence and fault location – Fault dominance – Single stuck at fault model – Multiple stuck at fault models –Bridging fault model.
Fault diagnosis of combinational circuits by conventional methods – Path sensitization techniques, Boolean Difference method – Kohavi algorithm – Test algorithms – D algorithm, PODEM, Random testing, Transition count testing, Signature analysis and test bridging faults.

MODULE – V: Fault Diagnosis In Sequential Circuits [7 Periods]

Circuit Test Approach, Transition Check Approach – State identification and fault detection experiment, Machine identification, Design of fault detection experiment

TEXT BOOKS:

1. Charles H. Roth, **Fundamentals of Logic Design** ,Cengage Learning,5th Ed.

2. MironAbramovici, Melvin A. Breuer and Arthur D. Friedman **, Digital Systems Testing and Testable Design**, John Wiley & Sons Inc.
3. N. N. Biswas ,**Logic Design Theory** , PHI.

REFERENCE BOOKS:

1. Z. Kohavi ,**Switching and Finite Automata Theory**, TMH, 2nd Ed,2001.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Design digital circuits by their own for new applications.
2. Identify techniques to improve fault diagnosis for digital circuits.

Malla Reddy Engineering College (Autonomous)

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4 - -

Course Code: 54103 **Credits: 4**

M.Tech. – I Semester

ADVANCED DATA COMMUNICATIONS

PREREQUISITES: Digital Modulation, Encoding Codes and Multiplexing Techniques.

OBJECTIVE: Gives an overview of the digital modulation techniques like QAM, PSK etc and its calculation of bandwidth efficiency, carrier recovery and clock recovery, Introduce students to the evolution of computer networks and the concepts data Communication and compare the different network topologies, Provide students with in-depth knowledge of data link layer fundamental such as error detection, correction and flow control techniques. Different types of data link protocols introduced, Gives an overview of multiplexing techniques, examples of local area networks and metropolitan area networks. The general principles of circuit and packet switching, to introduce the different types of multiple access techniques

MODULE – I :Digital Modulation Schemes **[8 Periods]**

BPSK, QPSK, 8PSK, 16PSK, 8QAM, 16QAM, DPSK – Methods, Band Width Efficiency, Carrier Recovery, Clock Recovery.

MODULE–II: Basic Concepts Of Data Communications, Interfaces And Modems **[9 Periods]**

Data Communication Networks, Protocols and Standards, UART, USB, I2C, I2S, Line Configuration, Topology, Transmission Modes, Digital Data Transmission, DTE-DCE interface, Categories of Networks – TCP/IP Protocol suite and Comparison with OSI model.

MODULE – III: Error Correction **[8 Periods]**

Types of Errors, Vertical Redundancy Check (VRC), LRC, CRC, Checksum, Error Correction using Hamming code.

Data Link Control: Line Discipline, Flow Control, Error Control

Data Link Protocols: Asynchronous Protocols, Synchronous Protocols, Character Oriented Protocols, Bit-Oriented Protocol, Link Access Procedures.

MODULE – IV : Multiplexing **[10 Periods]**

Frequency Division Multiplexing (FDM), Time Division Multiplexing (TDM), Multiplexing Application, DSL.

Local Area Networks: Ethernet, Other Ether Networks, Token Bus, Token Ring, FDDI.

Metropolitan Area Networks: IEEE 802.6, SMDS

Switching: Circuit Switching, Packet Switching, Message Switching.

Networking and Interfacing Devices: Repeaters, Bridges, Routers, Gateway, Other Devices.

MODULE – V: Multiple Access Techniques **[9 Periods]**

Random Access, Aloha- Carrier Sense Multiple Access (CSMA)- Carrier Sense Multiple Access withCollision Avoidance (CSMA/CA), Controlled Access- Reservation- Polling- Token Passing, Channelization, Frequency- Division Multiple Access (FDMA),

Time - Division Multiple Access (TDMA), Code - Division Multiple Access (CDMA), OFDM and OFDMA.

TEXT BOOKS:

1. B. A.Forouzan **, Data Communication and Computer Networking**, TMH , 2nd Ed,2003.
2. W. Tomasi ,**Advanced Electronic Communication Systems** , PEI ,5th Ed,2008.

REFERENCE BOOKS:

1. Prakash C. Gupta, **Data Communications and Computer Networks**, PHI ,2006.
2. William Stallings, **Data and Computer Communications**, PHI, 8th Ed., 2007.
3. T. Housely ,**Data Communication and Tele Processing Systems**, BSP ,2nd Ed, 2008.
4. Brijendra Singh ,**Data Communications and Computer Networks**,2nd Ed., 2005.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. On completion of this unit student will understand the importance of different types of digital modulation techniques and how these techniques will be useful for the transmission of data
2. Explain the importance of data communications and the Internet in supporting business communications and daily activities. Explain how communication works in data networks and the Internet. Understand the basic principles of network design.

3. On completion of this unit student will understand the different types of errors and how to correct these errors using different types of techniques and analyze the data link control techniques and protocols.

4. Recognize the different internetworking devices and their functions and analyze the services and features of the LAN'S, MAN'S. Able to identify various switching techniques in data communication system

5. Able to understand the different types of multiple access techniques

Malla Reddy Engineering College (Autonomous)

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Course Code: 54104 **Credits: 4**

M.Tech. – I Semester

HARDWARE AND SOFTWARE CO-DESIGN

(Professional Elective - I)

PREREQUISITES: Concepts of Models and Architectures

OBJECTIVE: To design mixed hardware-software systems and the design of hardware-software interfaces, To focus on common underlying modeling concepts, and the trade-offs between hardware and software components, To learn about System –level specification, design representation for system level synthesis, system level specification languages.

Module –I: Co- Design Issues [10 Periods]

Co- Design Models, Architectures, Languages, A Generic Co-design Methodology.

Co- synthesis algorithms: Hardware software synthesis algorithms: hardware – software partitioning distributed system co synthesis.

Module –II: Prototyping And Emulation [8 Periods]

Prototyping and emulation techniques, prototyping and emulation environments, future developments in emulation and prototyping architecture specialization techniques, system communication infrastructure

Target architectures: Architecture Specialization techniques, System Communication infrastructure, Target Architecture and Application System classes, Architecture for control dominated systems (8051-Architectures for High performance control), Architecture for Data dominated systems (ADSP21060, TMS320C60),Mixed Systems.

Module –III: Compilation Techniques and Tools for Embedded Processor Architectures [8 Periods]

Modern embedded architectures, embedded software development needs, compilation technologies, practical consideration in a compiler development environment.

Module –IV: Design Specification and Verification [10 Periods]

Design, co-design, the co-design computational model, concurrency coordinating concurrent computations, interfacing components, design verification, implementation verification, verification tools, interface verification

Module –V: Languages For System – Level Specification And Design-I [9 Periods]

System – level specification, design representation for system level synthesis, system level specification languages,

Languages for system – level specification and design-ii: Heterogeneous specifications and multi language co-simulation, the cosyma system and lycossystem.

TEXT BOOKS:

1. Jorgen Staunstrup, Wayne Wolf, **Hardware / Software Co- Design Principles and Practice**, Springer, 2009.

2. Giovanni De Micheli, Mariagiovanna Sami, **Hardware / Software Co- Design** ,KluwerAcademic Publishers,2002.

REFERENCE BOOKS:

1. Patrick R. Schaumont , **A Practical Introduction to Hardware/Software Co-design**, Springer,2010.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Able to design mixed hardware-software systems and the design of hardware-software interfaces
2. Able to focus on common underlying modeling concepts, , and the trade-offs between hardware and software components.
3. Able to learn about System –level specification, design representation for system level synthesis, system level specification languages.

Malla Reddy Engineering College (Autonomous)

L T P
4 - -

Course Code: 54105 **Credits: 4**

M.Tech. – I Semester

IMAGE AND VIDEO PROCESSING

(Professional Elective - I)

PREREQUISITES: Image and Video Transformations.

OBJECTIVE: To learn about Digital image fundamentals, image transforms, image enhancement, image segmentation and image compression techniques. to learn basics of video representation and video compression techniques and standards.

Module - I: Fundamentals of Image Processing and Image Transforms [9 Periods]
Basic steps of Image Processing System Sampling and Quantization of an image, Basic relationship between pixels.
Image Segmentation: Segmentation concepts, Point, Line and Edge Detection, Thresholding, Region based segmentation.

Module - II: Image Enhancement [8 Periods]
Spatial domain methods: Histogram processing, Fundamentals of Spatial filtering, Smoothing spatial filters, Sharpening spatial filters.
Frequency domain methods: Basics of filtering in frequency domain, image smoothing, imagesharpening, Selective filtering.

Module – III: Image Compression [8 Periods]
Image compression fundamentals - Coding Redundancy, Spatial and Temporal redundancy, Compression models: Lossy& Lossless, Huffman coding, Bit plane coding, Transform coding,Predictive coding, Wavelet coding, Lossy Predictive coding, JPEG Standards.

Module - IV: Basic Steps of Video Processing [10 Periods]
Analog Video, Digital Video. Time-Varying Image Formation models: Three-Dimensional Motion Models, Geometric Image Formation, Photometric Image Formation, Sampling of Video signals, filtering operations.

Module - V: 2-D Motion Estimation [8 Periods]
Optical flow, General Methodologies, Pixel Based Motion Estimation, Block- Matching Algorithm, Mesh based Motion Estimation, Global Motion Estimation, Region based Motion Estimation, Multi resolution motion estimation, Waveform based coding, Block based transform coding, Predictive coding, Application of motion estimation in Video coding.

TEXT BOOKS:
1. Gonzaleze and Woods, **Digital Image Processing ,Pearson** ,3rd Ed.
2. Yao Wang, JoemOstermann and Ya–quin Zhang,**Video Processing and Communication** , PH Int, 1st Ed.,.

REFRENCE BOOKS:
1. ScotteUmbaugh**, Digital Image Processing and Analysis-Human and Computer Vision Application with CVIP Tools**, CRC Press, 2nd Ed, 2011.
2. M. Tekalp , **Digital Video Processing** , Prentice Hall International.
3. S.Jayaraman, S.Esakkirajan, T.Veera Kumar , **Digital Image Processing** ,TMH, 2009.

4. John Woods,**Multidimentional Signal, Image and Video Processing and Coding**, Ed,Elsevier, 2nd.
5. Vipula Singh , **Digital Image Processing with MATLAB and Lab view**, Elsevier.
6. Keith Jack ,**Video Demystified – A Hand Book for the Digital Engineer**, Elsevier, 5th Ed.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Able to understand Digital imaging fundamentals, will get working level knowledge on DCT, DFT, FFT on images, various image enhancement & segmentation techniques
2. Able to understand the basic of video production, representation, pixel decimation, pixel interpolation, video compression techniques in MPEG-1/2/4/H.264.

2015-16

Malla Reddy Engineering College (Autonomous)

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Course Code: 54106 **Credits: 4**

M.Tech. – I Semester

EMBEDDED SYSTEM DESIGN

(Professional Elective - I)

PREREQUISITES: Microprocessors and Microcontrollers.

OBJECTIVE: This course introduces the difference between Embedded Systems and General purpose systems. This course familiarizes to compare different approaches in optimizing General purpose processors. This course provides the design tradeoffs made by different models of embedded systems.

Module - I: Introduction to Embedded Systems [8 Periods]

Definition of Embedded System, Embedded Systems Vs General Computing Systems, History of Embedded Systems, Classification, Major Application Areas, Purpose of Embedded Systems, Characteristics and Quality Attributes of Embedded Systems.

Module - II: Typical Embedded System [12 Periods]

Core of the Embedded System: General Purpose and Domain Specific Processors, ASICs, PLDs, Commercial Off-The-Shelf Components (COTS), Memory: ROM, RAM, Memory according to the type of Interface, Memory Shadowing, Memory selection for Embedded Systems, Sensors and Actuators, Communication Interface: Onboard and External Communication Interfaces.

Module - III: Embedded Firmware [10 Periods]

Reset Circuit, Brown-out Protection Circuit, Oscillator Unit, Real Time Clock, Watchdog Timer, Embedded Firmware Design Approaches and Development Languages.

Module - IV: RTOS Based Embedded System Design [12 Periods]

Operating System Basics, Types of Operating Systems, Tasks, Process and Threads, Multiprocessing and Multitasking, Task Scheduling.

Module - V: Task Communication [8 Periods]

Shared Memory, Message Passing, Remote Procedure Call and Sockets, Task Synchronization: Task Communication/Synchronization Issues, Task Synchronization Techniques, Device Drivers, How to Choose an RTOS.

TEXT BOOKS:

1. Shibu K.V, **Introduction to Embedded Systems**, McGraw Hill.

(Module – I, II, III, IV, V)

REFERENCE BOOKS:

1. Raj Kamal , **Embedded Systems**,TMH.
2. Frank Vahid, Tony Givargis, John Wiley, **Embedded System Design**.
3. Lyla **, Embedded Systems**, Pearson, 2013
4. David E. Simon, **An Embedded Software Primer** ,Pearson Education.

COURSE OUTCOMES:

At the end of the course students are able to:

1. Understand the basics of an embedded system.
2. Design, implement and test an embedded system.
3. Understand the design tradeoffs made by different models of embedded systems.

Malla Reddy Engineering College (Autonomous)

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Course Code: 54107 **Credits: 4**

M.Tech. – I Semester

CMOS DIGITAL INTEGRATED CIRCUIT DESIGN

(Professional Elective - II)

PREREQUISITES: VLSI Technology and IC Design

OBJECTIVE: To teach fundamentals of CMOS Digital integrated circuit design such as importance of Pseudo logic, Combinational MOS logic circuits, Sequential MOS logic circuits, To teach the fundamentals of Dynamic logic circuits and basic semiconductor memories which are the basics for the design of high performance digital integrated circuits.

Module - I **[10 Periods]**

MOS DESIGN: Pseudo NMOS Logic – Inverter, Inverter threshold voltage, Output high voltage, Output Low voltage, Gain at gate threshold voltage, Transient response, Rise time, Fall time, Pseudo NMOS logic gates, Transistor equivalency, CMOS Inverter logic.

Module - II **[8 Periods]**

COMBINATIONAL MOS LOGIC CIRCUITS:MOS logic circuits with NMOS loads, Primitive CMOS logic gates – NOR & NAND gate, Complex Logic circuits design – Realizing Boolean expressions using NMOS gates and CMOS gates , AOI and OIA gates, CMOS full adder, CMOS transmission gates, Designing with Transmission gates.

Module - III **[7 Periods]**

SEQUENTIAL MOS LOGIC CIRCUITS: Behavior of bistable elements, SR Latch, Clocked latch and flip flop circuits, CMOS D latch and edge triggered flipflop.

Module - IV **[10 Periods]**

DYNAMIC LOGIC CIRCUITS: Basic principle, Voltage Bootstrapping, Synchronous dynamic pass transistor circuits, Dynamic CMOS transmission gate logic, High performance Dynamic CMOS circuits.

Module - V **[8 Periods]**

SEMICONDUCTOR MEMORIES: Types, RAM array organization, DRAM – Types, Operation, Leakage currents in DRAM cell and refresh operation, SRAM operation Leakage currents in SRAM cells, Flash Memory- NOR flash and NAND flash.

TEXT BOOKS

1. Ken Martin**, Digital Integrated Circuit Design** , Oxford University Press, 2011.
2. Sung-Mo Kang, Yusuf Leblebici , **CMOS Digital Integrated Circuits Analysis and Design,** TMH, 3rd Ed., 2011.

REFERENCE BOOKS

1. Ming-BO Lin, **Introduction to VLSI Systems: A Logic, Circuit and System Perspective**, CRC Press, 2011
2. Jan M. Rabaey, Anantha Chandrakasan, Borivoje Nikolic , **Digital Integrated Circuits – A Design Perspective** , 2nd Ed,PHI.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Able to understand the realization of different logic circuit designs for logic expressions and the importance of the circuit designs , the drawback of the designs both in combinational as well as sequential.
2. Able to know different types of memories , performance evaluation of each memory modules they can be able to think how to improve performance by taking different structures

Malla Reddy Engineering College (Autonomous)

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Course Code: 54108 **Credits: 4**

M.Tech. – I Semester
INTERNETWORKING
(Professional Elective – II)

PREREQUISITES: Network Protocols

OBJECTIVE: To learn the Principles of Internetworking, Connectionless Internetworking, Application level Interconnections, Network level Interconnection, Properties of the Internet, Internet Architecture, Wired LANS, Wireless LANs, Point-to-Point WANs, Switched WANs, Connecting Devices, TCP/IP Protocol Suite. to know about Classful Addressing, Sub-netting and Super-netting, Variable length Blocks, Delivery, Forwarding, and Routing of IP Packets. to Know about TCP Services, TCP Features, Segment, A TCP Connection, State Transition Diagram, Flow Control, Error Control, Congestion Control, TCP Times

Module - I: Internetworking Concepts [10 Periods]
Principles of Internetworking, Connectionless Internetworking, Application level Interconnections, Network level Interconnection, Properties of the Internet, Internet Architecture, Wired LANS, Wireless LANs, Point-to-Point WANs, Switched WANs, Connecting Devices, TCP/IP Protocol Suite.
IP Address Classful Addressing: Introduction, Classful Addressing, Other Issues, Sub-netting and Super-netting
Classless Addressing: Variable length Blocks, Sub-netting, Address Allocation. Delivery, Forwarding, and Routing of IP Packets: Delivery, Forwarding, Routing, Structure of Router.
ARP and RARP: ARP, ARP Package, RARP.

Module – II: Internet Protocol (IP) [9 Periods]
Datagram, Fragmentation, Options, Checksum, IP V.6.
Transmission Control Protocol (TCP):TCP Services, TCP Features, Segment, A TCP Connection, State Transition Diagram, Flow Control, Error Control, Congestion Control, TCP Times.
Stream Control Transmission Protocol (SCTP):SCTP Services, SCTP Features, Packet Format, Flow Control, Error Control, Congestion Control.
Mobile IP: Addressing, Agents, Three Phases, Inefficiency in Mobile IP.
Classical TCP Improvements: Indirect TCP, Snooping TCP, Mobile TCP, Fast Retransmit/ Fast Recovery, Transmission/ Time Out Freezing, Selective Retransmission, Transaction Oriented TCP.

Module - III: Unicast Routing Protocols (RIP, OSPF, AND BGP) [10 Periods]
Intra and Inter-domain Routing, Distance Vector Routing, RIP, Link State Routing, OSPF, PathVector Routing, BGP.
Multicasting and Multicast Routing Protocols: Unicast - Multicast- Broadcast, Multicast Applications, Multicast Routing, Multicast Link State
Routing: MOSPF, Multicast Distance Vector: DVMRP.

Module - IV: Domain Name System (DNS) [11 Periods]
Name Space, Domain Name Space, Distribution of Name Space, and DNS in the internet. Remote Login TELNET: Concept, Network Virtual Terminal (NVT).File Transfer FTP and

TFTP: File Transfer Protocol (FTP). Electronic Mail: SMTP and POP.Network Management-SNMP: Concept, Management Components, World Wide Web- HTTP Architecture.

Module - V: Multimedia **[10 Periods]**

Digitizing Audio and Video, Network security, security in the internet firewalls. Audio and Video Compression, Streaming Stored Audio/Video, Streaming Live Audio/Video, Real-Time Interactive Audio/Video, RTP, RTCP, Voice Over IP. Network Security, Security in the Internet, Firewalls.

TEXT BOOKS:

1. Behrouz A. Forouzan , **TCP/IP Protocol Suite ,**TMH, Third Edition.
2. Comer, **Internetworking with TCP/IP**, PHI ,3rd Edition .

REFERENCE BOOKS:

1. Mahbub Hassan, Raj Jain **, High performance TCP/IP Networking**, PHI, 2005
2. B.A. Forouzan ,**Data Communications & Networking ,** TMH, 2nd Edition.
3. William Stallings, **High Speed Networks and Internets**, Pearson Education, 2002.
4. William Stallings, **Data and Computer Communication**s, PEI, 7th Edition.
5. Adrin Farrel, **The Internet and Its Protocols**, Elsevier, 2005.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Learn the Principles of Internetworking, Connectionless Internetworking, Application level Interconnections, Network level Interconnection, Properties of the Internet, Internet Architecture, Wired LANS, Wireless LANs, Point-to-Point WANs, Switched WANs, Connecting Devices, TCP/IP Protocol Suite.
2. Know about Classful Addressing, Sub-netting and Super-netting, Variable length Blocks, Delivery, Forwarding, and Routing of IP Packets.
3. Know about TCP Services, TCP Features, Segment, A TCP Connection, State Transition Diagram, Flow Control, Error Control, Congestion Control, TCP Times

Malla Reddy Engineering College (Autonomous)

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Course Code: 54109 **Credits: 4**

M.Tech. – I Semester

DESIGN OF FAULT TOLERANT SYSTEMS

(Professional Elective -II)

PREREQUISITES: STLD

OBJECTIVE: To know about Reliability Concepts, Failure & Faults, Reliability and Failure rate, Relation between Reliability and Meantime between failure, Maintainability and Availability, Reliability of series, parallel and Parallel – Series combinational circuits, To know about Basic concepts of self checking circuits, Design of Totally self checking checker, checkers using m out of n codes, Berger code, Low Cost residue code, To learn about Basic concepts of Testability, Controllability and Observability, The Reed Muller's expansion technique, OR-AND-OR Design, Use of control and Syndrome Testable Designs.

Module – I: Fault Tolerant Design **[10 Periods]**

Basic Concepts: Reliability Concepts, Failure & Faults, Reliability and Failure rate, Relation between Reliability and Meantime between failure, Maintainability and Availability, Reliability of series, parallel and Parallel – Series combinational circuits.

Fault Tolerant Design: Basic Concepts – Static, dynamic, hybrid Triple Modular Redundant System, Self purging redundancy, Siftout redundancy (SMR), 5 MR Re-Configuration techniques, Use of error correcting code. Time redundancy and software redundancy

Module - II: Self Checking Circuits & Fail Safe Design **[9 Periods]**

Self Checking circuits: Basic concepts of self checking circuits, Design of Totally self checking checker, checkers using m out of n codes, Berger code, Low Cost residue code.

Fail Safe Design: Strongly fault secure circuits, fail safe design of sequential circuits using partition theory and Berger code, totally self checking PLA Design

Module - III: APTG Fundamentals and Design for Testability for Combinational Circuit **[10 Periods]**

Introduction to ATPG, ATPG Process – Testability and Fault analysis methods – Fault masking – Transition delay fault ATPG, Path delay, fault ATPG.

Design for Testability for Combinational Circuits: Basic concepts of Testability, Controllability and Observability, The Reed Muller's expansion technique, OR-AND-OR Design, Use of control and Syndrome Testable Designs

Module - IV: Scan Architectures & Techniques **[9 Periods]**

Introduction to Scan Based testing, Functional testing, The Scan effective Circuit, The MUX-D Stule Scan flip-flops, The Scan shift register, scan cell operation,Scan test sequencing, scan testing timing, partial scan, multiple scan chains, scan based design rules (LSSD) At-speed scan testing and Architecture, multiple clock and scan domain operation, critical paths for At speed scan test.

Module - V: Built In Self Test (BIST) **[11 Periods]**

BIST concepts, Tests Pattern generation for BIST exhaustive testing, pseudorandom testing, pseudo exhaustive testing, constant weight patterns, Generic offline BIST architecture, Memory Test architecture.

TEXT BOOKS:

1. Parag K. Lala , **Fault Tolerant & Fault Testable Hardware Design**, PHI, 1984.
2. Alfred L. Crouch, **Design for Test for Digital IC's and Embedded Core Systems** Pearson Education, 2008.

REFERENCE BOOKS:

1. Miron Abramovici, Melvin A. Breuer and Arthur D. Friedman, **Digital Systems Testing and Testable Design,** Jaico Books
2. Bushnell & Vishwani D.Agarwal , **Essentials of Electronic Testing**, Springers.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Know about Reliability Concepts, Failure & Faults, Reliability and Failure rate, Relation between Reliability and Meantime between failure, Maintainability and Availability, Reliability of series, parallel and Parallel – Series combinational circuits.
2. Know about Basic concepts of self checking circuits, Design of Totally self checking checker, checkers using m out of n codes, Berger code, Low Cost residue code.
3. Learn about Basic concepts of Testability, Controllability and Observability, The Reed Muller's expansion technique, OR-AND-OR Design, Use of control and Syndrome Testable Designs

2015-16

Malla Reddy Engineering College (Autonomous)

L	T	P
4	-	-

Course Code: 54110 **Credits: 4**

M.Tech. – I Semester

CODING THEORY AND TECHNIQUES

(Professional Elective –III)

PREREQUISITES: Coding Techniques.

OBJECTIVE: To know about the Information theory and source coding techniques. to learn concepts of channel coding techniques.

Module - I: Source Coding **[10 Periods]**

Mathematical model of Information, A Logarithmic Measure of Information, Average and Mutual Information and Entropy, coding for discrete less sources, Source coding theorem, fixed length and variable length coding, properties of prefix codes,Shannon-Fano coding, Huffman code, Huffman code applied for pair of symbols, efficiency calculations, Lempel-Ziv codes.

Module - II: Linear Block Codes **[8 Periods]**

Introduction to Linear block codes, Generator Matrix, Systematic Linear Block codes, Encoder Implementation of Linear Block Codes, Parity Check Matrix, Syndrome testing, Error Detecting and correcting capability of Linear Block codes. Hamming Codes, Probability of an undetected error for linear codes over a Binary Symmetric Channel, Weight Enumerators and Mac-Williams identities, Perfect codes, Application of Block codes for error control in data storage Systems.

Module - III: Cyclic Codes **[9 Periods]**

Algebraic structure of cyclic codes, Binary Cyclic code properties, Encoding in systematic and non-systematic form, Encoder using (n-k) bit shift register, Syndrome Computation and Error detection, Decoding of Cyclic Codes.

Module - IV: Convolution Codes **[10 Periods]**

Encoding of Convolution codes, Structural properties of Convolutional codes, state diagram, Tree diagram, Trellis Diagram, maximum, Likelihood decoding of Convolutional codes.Viterbi Algorithm, Fano, Stack Sequential decoding algorithms, Application of Viterbi and sequential decoding.

Module - V: BCH Codes **[11 Periods]**

Groups, fields, binary Fields arithmetic, construction of Falois fields GF (2m), Basic properties of Falois Fields, Computation using Falois Field GF (2m) arithmetic, Description of BCH codes, Decoding procedure for BCH codes.

TEXT BOOKS:

1. SHU LIN and Daniel J. Costello, **Error Control Coding – Fundamentals and Applications**, Jr. Prentice Hall Inc.
2. Fundamental and Application by Bernard Sklar , **Digital Communications** , Pearson Education Asia.
3. Man Young Rhee, **Error Control Coding Theory**, Mc. Graw Hill Publ.

REFERENCE BOOKS:

1. John G. Proakis, **Digital Communications**, Mc. Graw Hill Publication.
2. K. Sam Shanmugam, **Digital and Analog Communication Systems**.
3. Symon Haykin , **Digital Communications**.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Know about the Information, Entropy, Sourse coding techniques such as Shannon-Fano, Huffman ,Lempel Ziv coding techniques.
2. Understand channel coding techniques such as block code ,cyclic code, convolution codes and BCH codes.

2015-16

Malla Reddy Engineering College (Autonomous)

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Course Code: 54111 **Credits: 4**

M.Tech. – I Semester

SOFT COMPUTING TECHNIQUES

(Professional Elective -III)

PREREQUISITES: Neural Networks and Fuzzy Logic Systems.

OBJECTIVE: To know about Approaches to intelligent control, Architecture for intelligent control, Symbolic reasoning system, Rule based systems, To know about Concept of Artificial Neural Networks and its basic mathematical model, McCulloch-Pitts neuron model, simple perception, Adeline and Madeline, Feed-forward Multilayer Perceptron, Learning and Training the neural network, To learn about fuzzy sets, basic fuzzy set operation and approximate reasoning, Introduction to fuzzy logic modeling and control, Fuzzification, inferencing and defuzzification, Fuzzy knowledge and rule bases, Fuzzy modeling

Module – I: Introduction **[10 Periods]**

Approaches to intelligent control, Architecture for intelligent control, Symbolic reasoning system, Rulebased systems, the AI approach, Knowledge representation - Expert systems.

Module - II: Artificial Neural Networks **[9 Periods]**

Concept of Artificial Neural Networks and its basic mathematical model, McCulloch-Pitts neuron model, simple perceptron, Adaline and Madaline, Feed-forward Multilayer Perceptron, Learning and Training the neural network, Data Processing: Scaling, Fourier transformation, principal-component analysis and wavelet transformations, Hopfield network, Self-organizing network and Recurrent network, Neural Network based controller.

Module - III: Fuzzy Logic System **[8 Periods]**

Introduction to crisp sets and fuzzy sets, basic fuzzy set operation and approximate reasoning,Introduction to fuzzy logic modeling and control, Fuzzification, inferencing and defuzzification, Fuzzy knowledge and rule bases, Fuzzy modeling and control schemes for nonlinear systems, Selforganizing fuzzy logic control, Fuzzy logic control for nonlinear time delay system.

Module - IV : Genetic Algorithm **[10 Periods]**

Basic concept of Genetic algorithm and detail algorithmic steps, Adjustment of free parameters,Solution of typical control problems using genetic algorithm, Concept on some other searchtechniques like Tabu search and anD-colony search techniques for solving optimization problems.

Module - V: Applications **[11 Periods]**

GA application to power system optimisation problem, Case studies: Identification and control of linear and nonlinear dynamic systems using MATLAB-Neural Network toolbox, Stability analysis of Neural-Network interconnection systems, Implementation of fuzzy logic controller using MATLAB fuzzy-logic toolbox, Stability analysis of fuzzy control systems.

TEXT BOOKS:

1. Jacek.M.Zurada , **Introduction to Artificial Neural Systems**, Jaico Publishing House, 1999.
2. Kosko, B., Prentice, **Neural Networks and Fuzzy Systems**, Hall of India Pvt. Ltd., 1994.

REFERENCE BOOKS:

1. Klir G.J. & Folger T.A, **Fuzzy Sets, Uncertainty and Information**, Prentice-Hall of India Pvt.Ltd, 1993.
2. Zimmerman H.J, **Fuzzy Set Theory and Its Applications**, Kluwer Academic Publishers, 1994.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Know about Approaches to intelligent control, Architecture for intelligent control, Symbolic reasoning system, Rule based systems.
2. Know about Concept of Artificial Neural Networks and its basic mathematical model, McCulloch-Pitts neuron model, simple perception, Adeline and Madeline, Feed-forward Multilayer Perceptron, Learning and Training the neural network.
3. Learn about fuzzy sets, basic fuzzy set operation and approximate reasoning, Introduction to fuzzy logic modeling and control, Fuzzification, inferencing and defuzzification, Fuzzy knowledge and rule bases, Fuzzy modeling

Malla Reddy Engineering College (Autonomous)

L	T	P
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Course Code: 54112 **Credits: 4**

M.Tech. – I Semester

NANOELECTRONICS

(Professional Elective - III)

PREREQUISITES: Physics and Electronics.

OBJECTIVE: To Introduce the concepts of Nano Electronic Components and their properties

Module - I: Introduction to Physics of Solid State [8 Periods]

Structure–Size dependence of properties, crystal structures, Face centered cubic nano particles, tetrahedral bonded semiconductor structures, lattice vibrations, Energy bands – insulators, semiconductors and conductors, reciprocal space, energy bonds and gaps of semiconductors, effective masses, Fermi surfaces, Localized particles – donors, acceptors and deep traps, mobility, excitons.

Module - II: Basics of Nano electronics [9 Periods]

Electromagnetic Fields and Photons, Quantization of Action, Charge and Flux, Electrons behaving as waves, Electrons in potential wells, Photons interacting with electrons in solids, Diffusion Processes.

Module - III: Quantum Electronics [10 Periods]

Quantum electronic devices (QED): Upcoming electronic devices, Electrons in Mesoscopic structures, Examples of Quantum Electronic Devices: Short-Channel MOS Transistor, Split-Gate Transistor, Electron–Wave Transistor, Electron-Spin Transistor, Quantum Cellular Automata (QCA), Quantum Dot Array.

Module - IV: Molecular Electronics [7 Periods]

Switches based on Fullerenes and Nano tubes, Polymer Electronics, Self-Assembling Circuits, Optical Molecular Memories.

Module - V: Nano electronics With Tunneling Devices [12 Periods]

Tunneling Element (TE) – Tunnel effect and tunneling elements, Tunneling diode (TD), Resonant Tunneling diode (RTD), Three-terminal resonant tunneling devices, Technology of RTD.

Digital Circuit design based on RTDs: Memory applications, basic logic circuits, Dynamic logic circuits, Digital circuit design based on RTBT (resonant tunneling bipolar transistor): RTBT mobile, RTBT threshold gate, RTBT multiplexer.

TEXT BOOKS:

1. Karl Goser, K. Glosekotter, J. Dienstuhl, **Nano electronics and Nano systems: From**
2. **Transistors to Molecular and Quantum Devices**, Springer, third reprint 2009.
3. Charles Poole and Frank Owens, **Introduction to Nanotechnology**, Wiley India, 2007.

REFERENCES:

1.W.R. Fahrner, **Nanotechnology and Nano Electronics – Materials, devices and measurement Techniques,** Springer.
2.T.Pradeep , **Nano: The Essentials – Understanding Nano Scinece and Nanotechnology** Tata Mc.Graw Hill.
3.W. Ranier, **"Nano Electronics and Information Technology",** Wiley, (2003).

4.K.E. Drexler, **"Nano Systems",** Wiley, (1992).
5.H.S. Nalwa, **Encyclopedia of Nanotechnology** , American Scientific Publishers

COURSE OUTCOMES:
After completion of the course, students will be able to:

1. Give an overview on Nano Electronics Materials.
2. Demonstrate different properties and Components of Nano Electronics.

2015-16

Malla Reddy Engineering College (Autonomous)

L	T	P
-	-	4

Course Code: 54113 **Credits: 2**

M.Tech. – I Semester

VLSI LAB

Note: Programming can be done using any complier. Down load the programs on XILINX FPGA/CPLD boards.

List of experiments:

1. HDL code to realize all the logic gates
2. Design and Simulation of half adder, full adder, parallel adder and Serial Binary Adder.
3. Design of decoders
4. Design of encoders (without and with priority)
5. Design of 4 bit binary to gray converter
6. Design of Multiplexer/ Demultiplexer, comparator
7. Design of 4- Bit Multiplier
8. Design of flip flops: SR, D, JK, T
9. Design of 4-bit binary, BCD counters.
10. Design of a N- bit universal shift register.
11. Design of Sequence Detector (Finite State Machine- Mealy and Moore Machines).
12. Design of ALU to Perform – ADD, SUB, AND-OR, 1's and 2's Compliment, Multiplication, and Division.

2015-16

Malla Reddy Engineering College (Autonomous)

L	T	P
-	-	4

Course Code: 54114 **Credits: 2**

M.Tech. – I Semester

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Malla Reddy Engineering College (Autonomous)

L	T	P
4	-	-

Course Code: 55134 **Credits: 4**

M.Tech. – II Semester

ADVANCED COMPUTER ARCHITECTURE

PREREQUISITES: Computer Networks and Computer Architecture.

OBJECTIVE: To emphasize on the concept of a complete system consisting of asynchronous interactions between concurrently executing hardware components and device driver software in order to illustrate the behavior of a computer system as a whole, To understand the advanced concepts of computer architecture and exposing the major differentials of RISC and CISC architectural characteristics.

Module - I: Fundamentals of Computer Design [10 Periods]

Fundamentals of Computer design, Changing faces of computing and task of computer designer, Technology trends, Cost price and their trends, measuring and reporting performance, Quantitative principles of computer design, Amdahl's law. Instruction set principles and examples- Introduction, classifying instruction set- memory addressing type and size of operands, Operations in the instruction set.

Module - II: Pipelines [8 Periods]

Introduction, basic RISC instruction set, Simple implementation of RISC instruction set, Classic five stage pipe lined RISC processor, Basic performance issues in pipelining, Pipeline hazards, Reducing pipeline branch penalties. **Memory Hierarchy Design:** Introduction, review of ABC of cache, Cache performance, Reducing cache miss penalty, Virtual memory.

Module - III: Instruction Level Parallelism (IlP) - The Hardware Approach [10 Periods]

Instruction-Level parallelism, Dynamic scheduling, Dynamic scheduling using Tomasulo's approach, Branch prediction, High performance instruction delivery- Hardware based speculation. **ILP Software Approach:** Basic compiler level techniques, Static branch prediction, VLIW approach, Exploiting ILP, Parallelism at compile time, Cross cutting issues - Hardware verses Software.

Module - IV: Multi Processors and Thread Level Parallelism [7 Periods]

Multi Processors and Thread level Parallelism- Introduction, Characteristics of application domain, Systematic shared memory architecture, Distributed shared – Memory architecture, Synchronization.

Module - V: Inter Connection and Networks [8 Periods]

Introductions, Interconnection network media, Practical issues in interconnecting networks, Examples of inter connection, Cluster, Designing of clusters.
Intel Architecture: Intel IA-64 ILP in embedded and mobile markets Fallacies and pit falls.

TEXT BOOKS:

1. John L. Hennessy, David A. Patterson, **Computer Architecture: A Quantitative Approach**, an Imprint of Elsevier, 3rd Edition.

REFERENCE BOOKS:

1. John P. Shen and Miikko H. Lipasti **-, Modern Processor Design : Fundamentals of Super Scalar Processors**
2. Kai Hwang, Faye A.Brigs, Computer **Architecture and Parallel Processing** , MC Graw Hill.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Understand the advanced concepts of computer architecture and exposing the major differentials of RISC and CISC architectural characteristics.
2. Investigating modern design structures of Pipelined and Multiprocessors systems.
3. Become acquainted with recent computer architectures and I/O devices, as well as the low-level language required to drive/manage these types of advanced hardware.

2015-16

Malla Reddy Engineering College (Autonomous)

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Course Code: 54115 **Credits: 4**

M.Tech. – II Semester

DIGITAL SIGNAL PROCESSORS AND ARCHITECTURES

PREREQUISITES: Signal Processing and Embedded Systems

OBJECTIVE: To impart the knowledge of basic DSP filters and number systems to be used, different types of A/D,D/A conversion errors. to gain concepts of digital signal processing techniques, implementation of DSP & FFT algorithms and also to learn about Interfacing of serial & parallel communication devices to the processor.

Module - I: Introduction to Digital Signal Processing [10 Periods]

Introduction to a Digital signal-processing system, the sampling process, discrete time sequences. Discrete Fourier Transform (DFT) and Fast Fourier Transform (FFT), linear time-invariant systems, Digital filters, Decimation and interpolation.

Computational Accuracy in DSP Implementations: Number formats for signals and coefficients in DSP systems, Dynamic Range and Precision, Sources of error in DSP implementations, A/D Conversion errors, DSP Computational errors, D/A Conversion Errors, Compensating filter.

Module -II: Architectures for Programmable DSP Devices [8 Periods]

Basic Architectural features, DSP Computational Building Blocks, Bus Architecture and Memory, Data Addressing Capabilities, Address Generation UNIT, Programmability and Program Execution, Speed Issues, Features for External interfacing.

Module - III: Programmable Digital Signal Processors [9 Periods]

Commercial Digital signal-processing Devices, Data Addressing modes of TMS320C54XX DSPs, Data Addressing modes of TMS320C54XX Processors, Memory space of TMS320C54XXProcessors, Program Control, TMS320C54XX Instructions and Programming, On-Chip Peripherals, Interrupts of TMS320C54XX Processors, Pipeline Operation of TMS320C54XX Processors.

Module - IV: Analog Devices Family of DSP Devices [10 Periods]

Analog Devices Family of DSP Devices – ALU and MAC block diagram, Shifter Instruction, Base Architecture of ADSP 2100, ADSP-2181 high performance Processor.

Introduction to Black fin Processor - The Black fin Processor, Introduction to Micro Signal Architecture, Overview of Hardware Processing Units and Register files, Address Arithmetic Unit, Control Unit, Bus Architecture and Memory, Basic Peripherals.

Module - V: Interfacing Memory and I/O Peripherals To Programmable DSP Devices [8 Periods]

Memory space organization, External bus interfacing signals, Memory interface, Parallel I/O interface, Programmed I/O, Interrupts and I/O, Direct memory access (DMA).

TEXT BOOKS:

1. Avtar Singh and S. Srinivasan, **Digital Signal Processing**, Thomson Publications, 2004.
2. K Padmanabhan, R. Vijayarajeswaran, Ananthi. S, **A Practical Approach to Digital Signal Processing**, New Age International, 2006/2009.

3. Woon-Seng Gan, Sen M. Kuo, **Embedded Signal Processing with the Micro Signal Architecture,**Wiley-IEEE Press, 2007

REFERENCE BOOKS:

1. B. Venkataramani and M. Bhaskar, **Digital Signal Processors, Architecture, Programming and Applications**, TMH, 2002.
2. Jonatham Stein, **Digital Signal Processing**, John Wiley, 2005.
3. Lapsley et al **, DSP Processor Fundamentals, Architectures & Features,** S. Chand & Co,2000.
4. The Applications Engineering Staff of Analog Devices, DSP Division, Edited by Amy Mar **, Digital Signal Processing Applications Using the ADSP-2100 Family** , PHI.
5. Steven W. Smith, Ph.D, California, **The Scientist and Engineer's Guide to Digital Signal Processing by Technical Publishing**, ISBN 0-9660176-3-3, 1997.
6. David J. Katz and Rick Gentile of Analog Devices, Newnes, **Embedded Media Processing**, ISBN 0750679123, 2005.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Comprehends the knowledge & concepts of digital signal processing techniques, basic building blocks, and implementation of DSP & FFT Algorithms.
2. Do Programming the DSP TMS320C54XX PROCESSOR and decimation interpolation filters, adaptive filters.
3. Learn about interfacing of serial & parallel communication devices to the processor.

2015-16

Malla Reddy Engineering College (Autonomous)

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Course Code: 54116 **Credits: 4**

M.Tech. – II Semester

REAL TIME OPERATING SYSTEMS

PREREQUISITES: Embedded System Concepts and Linux and UNIX Programming

OBJECTIVE:

- To learn fundamentals of UNIX operating system.
- To study implementation aspects of real time concepts.
- To study example RTOSs and applications.

Module - I: Introduction **[8 Periods]**

Introduction to UNIX/LINUX, Overview of Commands, File I/O,(open, create, close, lseek, read, write), Process Control (fork, vfork, exit, wait, waitpid, exec.

Module - II: Real Time Operating Systems **[9 Periods]**

Brief History of OS, Defining RTOS, The Scheduler, Objects, Services, Characteristics of RTOS, Defining a Task, asks States and Scheduling, Task Operations, Structure, Synchronization, Communication and Concurrency. Defining Semaphores, Operations and Use, Defining Message Queue, States, Content, Storage, Operations and Use

Module - III: Objects, Services and I/O **[7 Periods]**

Pipes, Event Registers, Signals, Other Building Blocks, Component Configuration, Basic I/O Concepts, I/O Subsystem

Module - IV: Exceptions, Interrupts and Timers **[8 Periods]**

Exceptions, Interrupts, Applications, Processing of Exceptions and Spurious Interrupts, Real Time Clocks, Programmable Timers, Timer Interrupt Service Routines (ISR), Soft Timers, Operations.

Module - V: Case Studies of RTOS **[9 Periods]**

RT Linux, MicroC/OS-II, Vx Works, Embedded Linux, Tiny OS and Basic Concepts of Android OS.

TEXT BOOKS:

1. Qing Li, **Real Time Concepts for Embedded Systems**, Elsevier, 2011

REFERENCE BOOKS:

1. Rajkamal, **Embedded Systems- Architecture, Programming and Design,**TMH, 2007,.
2. Richard Stevens, **Advanced UNIX Programming**,
3. Dr. Craig Hollabaugh , **Embedded Linux: Hardware, Software and Interfacing**

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Understand the fundamentals of UNIX operating system.
2. Understand the implementation aspects of real time concepts.
3. Understand the example RTOSs and applications.

2015-16

Malla Reddy Engineering College (Autonomous)

L	T	P
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Course Code: 54117 **Credits: 4**

M.Tech. – II Semester

CPLD AND FPGA ARCHITECURES AND APPLICATIONS

(Professional Elective -IV)

PREREQUISITES: STLD and VLSI

OBJECTIVE: To understand the types of programmable logic devices and what are the differences between these devices. What are the different complex programmable logic devices with examples, to know the types of FPGA's and their programming technologies. What are the programmable logic block architectures, their interconnects and what are applications of FPGA's, to understand about the SRAM programmable FPGA's and their programming technology. What are examples of SRAM programmable FPGA's i.e Xilinx FPGA's with block diagrams.

Module - I: Introduction to Programmable Logic Devices [10 Periods]

Introduction, Simple Programmable Logic Devices – Read Only Memories, Programmable Logic Arrays, Programmable Array Logic, Programmable Logic Devices/Generic Array Logic; Complex Programmable Logic Devices – Architecture of Xilinx Cool Runner XCR3064XL CPLD, CPLD Implementation of a Parallel Adder with Accumulation.

Module –II: Field Programmable Gate Arrays [9 Periods]

Organization of FPGAs, FPGA Programming Technologies, Programmable Logic Block Architectures, Programmable Interconnects, Programmable I/O blocks in FPGAs, Dedicated Specialized Components of FPGAs, Applications of FPGAs.

Module – III : SRAM Programmable FPGSs [8 Periods]

Introduction, Programming Technology, Device Architecture, The Xilinx XC2000, XC3000 andXC4000 Architectures.

Module -IV: Anti-Fuse Programmed FPGAs [8 Periods]

Introduction, Programming Technology, Device Architecture, TheActel ACT1, ACT2 and ACT3 Architectures.

Module – V: Design Applications [9 Periods]

General Design Issues, Counter Examples, A Fast Video Controller, A Position Tracker for a Robot Manipulator, A Fast DMA Controller, Designing Counters with ACT devices, Designing Adders and Accumulators with the ACT Architecture.

TEXT BOOKS:

1. Stephen M. Trimberger, Field **Programmable Gate Array Technology**,Springer International Edition.
2. Charles H. Roth Jr, Lizy Kurian John, **Digital Systems Design**, Cengage Learning.

REFERENCE BOOKS:

1. John V. Oldfield, Richard C. Dorf, **Field Programmable Gate Arrays**, Wiley India.

2. Pak K. Chan/Samiha Mourad, **Digital Design Using Field Programmable Gate Arrays** ,Pearson Low Price Edition.
3. Ian Grout, Elsevier, **Digital Systems Design with FPGAs and CPLDs**, Newnes.
4. Wayne Wolf, **FPGA based System Design**,Prentice Hall Modern Semiconductor DesignSeries.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. The students will have the knowledge of types of programmable logic devices and what are the differences between these devices.
2. The students will have the knowledge of types of FPGA's and their programming technologies, programmable logic block architectures, their interconnects and what are applications of FPGA's.
3. The students will be able to know the programming technology of SRAM programmable FPGA's with their internal logic diagrams.

2015-16

Malla Reddy Engineering College (Autonomous)

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Course Code: 54118 **Credits: 4**

M.Tech. – II Semester

NETWORK SECURITY AND CRYPTOGRAPHY

(Professional Elective -IV)

PREREQUISITES: Concepts of Security and Cryptography

OBJECTIVE: To learn about various security attacks, Conventional encryption methods. To learn about Public key cryptography and email privacy.

Module – I **[10 Periods]**

INTRODUCTION: Attacks, Services and Mechanisms, Security attacks, Security services, A Model for Internetwork security. Classical Techniques: Conventional Encryption model, Steganography, Classical Encryption Techniques.

Module - II **[10 Periods]**

MODERN TECHNIQUES: Simplified DES, Block Cipher Principles, Data Encryption standard, Strength of DES, Differential and Linear Cryptanalysis, Block Cipher Design Principles and Modes of operations.

Algorithms: Triple DES, International Data Encryption algorithm, Blowfish, RC5, CAST-128, RC2, Characteristics of Advanced Symmetric block cifers.

Conventional Encryption: Placement of Encryption function, Traffic confidentiality, Key distribution, Random Number Generation.

Public Key Cryptography: Principles, RSA Algorithm, Key Management, Diffie-Hellman Key exchange, Elliptic Curve Cryptography.

Module - III **[8 Periods]**

NUMBER THEORY: Prime and Relatively prime numbers, Modular arithmetic, Fermat's and Euler's theorems, Testing for primality, Euclid's Algorithm, the Chinese remainder theorem, Discrete logarithms.

Message authentication and Hash Functions:

Authentication requirements and functions, Message Authentication, Hash functions, Security of Hash functions and MACs.

Module – IV **[7 Periods]**

HASH AND MAC ALGORITHMS: MD File, Message digest Algorithm, Secure Hash Algorithm, RIPEMD-160, HMAC.

Digital signatures and Authentication Protocols: Digital signatures, Authentication Protocols, Digital signature standards.

Authentication Applications: Kerberos, X.509 directory Authentication service. Electronic Mail Security: Pretty Good Privacy, S/MIME.

Module - V **[10 Periods]**

IP Security: Overview, Architecture, Authentication, Encapsulating Security Payload, Combining security Associations, Key Management.

Web Security: Web Security requirements, secure sockets layer and Transport layer security, Secure Electronic Transaction.

Intruders, Viruses and Worms: Intruders, Viruses and Related threats.
Fire Walls: Fire wall Design Principles, Trusted systems.

TEXT BOOKS:

1. William Stallings **, Cryptography and Network Security: Principles and Practice**, Pearson Education.
2. William Stallings, **Network Security Essentials (Applications and Standards)**, Pearson Education.

REFERENCE BOOKS:

1. Eric Maiwald , Fundamentals of Network Security, Dreamtech press
2. Charlie Kaufman, Radia Perlman and Mike Speciner **, Network Security - Private Communication in a Public World** , Pearson/PHI.
3. Whitman, Thomson , **Principles of Information Security**.
4. Robert Bragg, Mark Rhodes **, Network Security: The complete reference** ,TMH
5. Buchmann , **Introduction to Cryptography**, Springer.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Know about Attacks, Services and Mechanisms, Security attacks, Security services, Conventional Encryption model, Steganography, Classical Encryption Techniques.
2. Know about the Algorithms like Triple DES, International Data Encryption algorithm, Blowfish, RC5, CAST-128, RC2, Characteristics of Advanced Symmetric block cifers.
3. Learn about Prime and Relatively prime numbers, Modular arithmetic, Fermat's and Euler's theorems, testing for primality, Euclid's Algorithm, the Chinese remainder theorem, and discrete logarithms.

2015-16

Malla Reddy Engineering College (Autonomous)

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4 - -

Course Code: 54119 **Credits: 4**

M.Tech. – II Semester

SYSTEM ON CHIP ARCHITECTURE

(Professional Elective -IV)

PREREQUISITES: Computer Architecture, Digital circuits and Embedded Systems.

OBJECTIVE: This course introduce to computer system design, with emphasis on fundamental ideas and analytical techniques that are applicable to a range of applications and architectures. This course introduces hardware and software programmability verses performance. This course introduces of entire memory organization, starch pads, cache memories and objective in cache data how to deal the write polices.

Module – I: Introduction to the System Approach [08 Periods]

System Architecture, Components of the system, Hardware & Software, Processor Architectures, Memory and Addressing. System level interconnection, An approach for SOC Design, System Architecture and Complexity.

Module – II: Processors [12 Periods]

Introduction , Processor Selection for SOC, Basic concepts in Processor Architecture, Basic concepts in Processor Micro Architecture, Basic elements in Instruction handling. Buffers: minimizing Pipeline Delays, Branches, More Robust Processors, Vector Processors and Vector Instructions extensions, VLIW Processors, Superscalar Processors.

Module – III: Memory Design for Soc [10 Periods]

Overview of SOC external memory, Internal Memory, Size, Scratchpads and Cache memory, Cache Organization, Cache data, Write Policies, Strategies for line replacement at miss time, Types of Cache, Split – I, and D – Caches, Multilevel Caches, Virtual to real translation , SOC Memory System, Models of Simple Processor – memory interaction.

Module – IV: Interconnects Customization and Configuration [12 Periods]

Inter Connect Architectures, Bus: Basic Architectures, SOC Standard Buses , Analytic Bus Models, Using the Bus model, Effects of Bus transactions and contention time. SOC Customization: An overview, Customizing Instruction Processor, Reconfiguration Technologies, Mapping design onto Reconfigurable devices, Instance- Specific design, Customizable Soft Processor, Reconfiguration - overhead analysis and trade-off analysis on reconfigurable Parallelism.

Module – V: APPLICATION STUDIES / CASE STUDIES [08 Periods]

SOC Design approach, AES algorithms, Design and evaluation, Image compression – JPEG compression.

TEXT BOOKS:

1. Michael J. Flynn and Wayne Luk, **"Computer System Design System on Chip"**, Wiely India Pvt. Ltd., 2012. (Modules I, II, III, IV & V)

REFERENCE BOOKS:

1. Steve Furber**, "ARM System on Chip Architecture",** Addison Wesley Professional, 2nd Edition, 2000.
2. Ricardo Reis, **"Design of System on a Chip: Devices and Components"**, Springer, 1st Edition, 2004.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Know how the system forms with the lot of component and has majority about system level interconnections
2. Understand hardware and software programmability verses performance
3. Know about entire memory organization, starch pads, cache memories and objective in cache data how to deal the write polices

2015-16

Malla Reddy Engineering College (Autonomous)

L T P
4 - -

Course Code: 54120 **Credits: 4**

M.Tech. – II Semester
LOW POWER VLSI DESIGN
(Professional Elective – V)

PREREQUISITES: VLSI Technology and Design.

OBJECTIVE: To Identify suitable techniques to reduce the power dissipation. To learn design of adders, multipliers and memory circuits with low power dissipation

Module - I **[10 Periods]**
FUNDAMENTALS: Need for Low Power Circuit Design, Sources of Power Dissipation – Switching Power Dissipation, Short Circuit Power Dissipation, Leakage Power Dissipation, Glitching Power Dissipation, Short Channel Effects –Drain Induced Barrier Lowering and Punch Through, Surface Scattering, Velocity Saturation, Impact Ionization, Hot Electron Effect.

Module - II **[10 Periods]**
LOW-POWER DESIGN APPROACHES:
Low-Power Design through Voltage Scaling – VTCMOS circuits, MTCMOS circuits, Architectural Level Approach –Pipelining and Parallel Processing Approaches.
Switched Capacitance Minimization Approaches:
System Level Measures, Circuit Level Measures, Mask level Measures.

Module - III **[9 Periods]**
LOW-VOLTAGE LOW-POWER ADDERS: Introduction, Standard Adder Cells, CMOS Adder's Architectures – Ripple Carry Adders, Carry Look-Ahead Adders, Carry Select Adders, Carry Save Adders, Low-Voltage Low-Power Design Techniques–Trends of Technology and Power Supply Voltage, Low-Voltage Low-Power Logic Styles.

Module - IV **[8 Periods]**
LOW-VOLTAGE LOW-POWER MULTIPLIERS: Introduction, Overview of Multiplication, Types of Multiplier Architectures, Braun Multiplier, Baugh-Wooley Multiplier, Booth Multiplier, Introduction to Wallace Tree Multiplier.

Module – V **[8 Periods]**
LOW-VOLTAGE LOW-POWER MEMORIES: Basics of ROM, Low-Power ROM Technology, Future Trend and Development of ROMs, Basics of SRAM, Memory Cell, Precharge and Equalization Circuit, Low-Power SRAM Technologies, Basics of DRAM, Self-Refresh Circuit, Future Trend and Development of DRAM.

TEXT BOOKS:

1. Sung-Mo Kang, Yusuf Leblebici, **CMOS Digital Integrated Circuits – Analysis and Design**, TMH, 2011.
2. Kiat-Seng Yeo, Kaushik Roy, **Low-Voltage, Low-Power VLSI Subsystems** –TMH Professional Engineering.

REFERENCE BOOKS:

1. Ming-BO Lin, **Introduction to VLSI Systems: A Logic, Circuit and System Perspective** ,CRC Press, 2011
2. **Low Power CMOS Design** , AnanthaChandrakasan, IEEE Press/Wiley International, 1998.
3. Kaushik Roy, Sharat C. Prasad, **Low Power CMOS VLSI Circuit Design –John Wiley & Sons**, 2000.
4. Gary K. Yeap, **Practical Low Power Digital VLSI Design**, Kluwer Academic Press, 2002.
5. A. Bellamour, M. I. Elamasri, **Low Power CMOS VLSI Circuit Design**, Kluwer Academic Press, 1995.
6. Siva G. Narendran, Anatha Chandrakasan, **Leakage in Nanometer CMOS Technologies, Springer**, 2005.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Clearly identify the sources of power consumption, analyze and estimate leakage power components in a given VLSI circuit.
2. Choose different types of SRAMs/DRAMs for low power applications.
3. Design low power arithmetic circuits and systems.
4. Decide at which level of abstraction it is advantageous to implement low power techniques in a VLSI system design.

2015-16

Malla Reddy Engineering College (Autonomous)

L T P
4 - -

Course Code: 54121 **Credits: 4**

M.Tech – II Semester
DESIGN FOR TESTABILITY
(Professional Elective - V)

PREREQUISITES: Digital Electronics, Digital signal Processing and VLSI Technology**.**

OBJECTIVE: To gain knowledge on digital testing as applied to VLSI design. to acquire knowledge on testing of algorithms for digital circuits, to learn various testing methods for digital circuits.

MODULE-I: Introduction to Testing [12 Periods]
Testing Philosophy, Role of Testing, Digital and Analog VLSI Testing, VLSI Technology Trends affecting Testing, Types of Testing, Fault Modeling: Defects, Errors and Faults, Functional Versus Structural Testing, Levels of Fault Models, Single Stuck-at Fault.

MODULE -II: Logic And Fault Simulation [12 Periods]
Simulation for Design Verification and Test Evaluation, Modeling Circuits for Simulation, Algorithms for True-value Simulation, Algorithms for Fault Simulation, ATPG.

MODULE-III: Testability Measures [12 Periods]
SCOAP Controllability and Observability, High Level Testability Measures, Digital DFT and Scan Design: Ad-Hoc DFT Methods, Scan Design, Partial-Scan Design, Variations of Scan.

MODULE-IV: Built-In Self-Test [12 Periods]
The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation, Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-Per-Scan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST.

MODULE-V: Boundary Scan Standard [12 Periods]
Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test Instructions, Pin Constraints of the Standard, Boundary Scan Description Language: BDSL Description Components, Pin Descriptions.

TEXT BOOKS:

1. M.L. Bushnell, V. D. Agrawal, **"Essentials of Electronic Testing for Digital, Memory and Mixed Signal VLSI Circuits",** Kluwer Academic Pulishers. 2004. (Modules I,II,III,IV & V)

REFERENCE BOOKS:

1. M. Abramovici, M.A.Breuer and A.D Friedman, **"Digital Systems and Testable Design"**, Jaico Publishing House.
2. P.K. Lala, **"Digital Circuits Testing and Testability"**, Academic Press.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Design complex digital systems using VLSI design methodology.
2. Design a digital system using given specifications and design constraints.
3. Assess logic and technology-septic parameters to control the functionality, system synchronization, power consumption, and Effects of circuit parasitic.

Malla Reddy Engineering College (Autonomous)

L	T	P
4	-	-

Course Code: 54122 **Credits: 4**

M.Tech. – II Semester

DEVICE MODELLING

(Professional Elective – V)

PREREQUISITES: Engineering Physics and Semiconductor Physics

OBJECTIVE: To know about Quantum Mechanics, Boltzman transport equation, Continuity equation, Poisson equation , To learn about Types and structures in monolithic technologies – Basic model (Eber-Moll) – Gunmel - Poon model dynamic model, Parasitic effects – SPICE model –Parameter extraction , To learn about An overview of wafer fabrication, Wafer Processing – Oxidation –Patterning – Diffusion – Ion Implantation – Deposition – Silicon gate nMOS process – CMOS

Module - I: **[8 Periods]**

INTRODUCTION TO SEMICONDUCTOR PHYSICS: Review of Quantum Mechanics, Boltzman transport equation, Continuity equation, Poisson equation.
Integrated Passive Devices: Types and Structures of resistors and capacitors in monolithic technology, Dependence of model parameters on structures

Module -II: **[9 Periods]**

INTEGRATED DIODES: Junction and Schottky diodes in monolithic technologies – Static and Dynamic behavior – Small and large signal models – SPICE models
Integrated Bipolar Transistor: Types and structures in monolithic technologies – Basic model (Eber-Moll) – Gunmel - Poon model dynamicmodel, Parasitic effects – SPICE model –Parameter extraction.

Module - III: **[11 Periods]**

INTEGRATED MOS TRANSISTOR:NMOS and PMOS transistor – Threshold voltage – Threshold voltage equations – MOS device equations – Basic DC equations second order effects – MOS models – small signal AC characteristics– MOS FET SPICE model level 1, 2, 3 and 4.

Module - IV: **[10 Periods]**

VLSI FABRICATION TECHNIQUES: An overview of wafer fabrication, Wafer Processing – Oxidation –Patterning – Diffusion – Ion Implantation – Deposition – Silicon gate nMOS process – CMOS processes – n-well- p-well- twin tub- Silicon on insulator – CMOS process enhancements –Interconnects circuit elements

Module - V: **[8 Periods]**

MODELING OF HETERO JUNCTION DEVICES: Band gap Engineering, Band gap Offset at abrupt Hetero Junction, Modified current continuity equations, Hetero Junction bipolar transistors (HBTs), SiGe

TEXT BOOKS:

1. Tyagi M. S, **Introduction to Semiconductor Materials and Devices,** John Wiley Student Edition,2008.
2. Ben G. Streetman, **Solid State Circuits**, Prentice Hall, 1997

REFERENCE BOOKS:

1. Sze S. M, **Physics of Semiconductor Devices**, Mcgraw Hill ,2nd Edition, New York, 1981.
2. Tor A. Fijedly, **Introduction to Device Modeling and Circuit Simulation** ,Wiley-Interscience, 1997.
3. Ming-BO Lin, **Introduction to VLSI Systems: A Logic, Circuit and System Perspective ,** CRC Press, 2011

COURSE OUTCOMES:

1. Able to know about Quantum Mechanics, Boltzman transport equation, Continuity equation, Poisson equation.
2. Able to learn about Types and structures in monolithic technologies – Basic model (Eber-Moll) – Gunmel - Poon model dynamicmodel, Parasitic effects – SPICE model –Parameter extraction.
3. Able to learn about An overview of wafer fabrication, Wafer Processing – Oxidation –Patterning – Diffusion – Ion Implantation – Deposition – Silicon gate nMOS process – CMOS

2015-16

Malla Reddy Engineering College (Autonomous)

L T P
4 - -

Course Code: 54123 **Credits: 4**

M.Tech. – II Semester

SOFTWARE DEFINED RADIO

(Professional Elective – VI)

PREREQUISITES: Communication Networks.

OBJECTIVE: To introduce the concepts of radio Communication and Resource Management

Module - I: Introduction [10 Periods]

The Need for Software Radios, What is Software Radio, Characteristics and benefits of software radio- Design Principles of Software Radio, RF Implementation issues- The Purpose of RF Front – End, Dynamic Range- The Principal Challenge of Receiver Design – RF Receiver Front- End Topologies- Enhanced Flexibility of the RF Chain with Software Radios- Importance of the Components to Overall Performance- Transmitter Architectures and Their Issues- Noise and Distortion in the RF Chain, ADC and DAC Distortion.

Module - II: Profile and Radio Resource Management [8 Periods]

Communication Profiles- Introduction, Communication Profiles, Terminal Profile, Service Profile , Network Profile, User Profile, Communication Profile Architecture, Profile Data Structure, XML Structure, Distribution of Profile Data, Access to Profile Data, Management of Communication Profiles, Communication Classmarks, Dynamic Classmarks for Reconfigurable Terminals, Compression and Coding, Meta Profile Data

Module - III: Radio Resource Management in Heterogeneous Networks [8 Periods]

Introduction, Definition of Radio Resource Management, Radio Resource Units over RRM Phases, RRM Challenges and Approaches, RRM Modelling and Investigation Approaches, Investigations of JRRM in Heterogeneous Networks, Measuring Gain in the Upper Bound Due to JRRM, Circuit-Switched System, Packet-Switched System, Functions and Principles of JRRM, General Architecture of JRRM, Detailed RRM Functions in Sub-Networks and Overall Systems

Module - IV: Reconfiguration of the Network Elements [10 Periods]

Introduction, Reconfiguration of Base Stations and Mobile Terminals, Abstract Modelling of Reconfigurable Devices, the Role of Local Intelligence in Reconfiguration, Performance Issues, Classification and Rating of Reconfigurable Hardware, Processing Elements, Connection Elements, Global Interconnect Networks, Hierarchical Interconnect Networks, Installing a New Configuration, Applying Reconfiguration Strategies, Reconfiguration Based on Comparison, Resource Recycling, Flexible Workload Management at the Physical Layer,

Optimized Reconfiguration, Optimization Parameters and Algorithms, Optimization Algorithms, Specific Reconfiguration Requirements, Reconfiguring Base Stations, Reconfiguring Mobile Terminals

Module - V: Object – Oriented Representation of Radios and Network Resources

[8 Periods]

Networks- Object Oriented Programming- Object Brokers- Mobile Application Environments- Joint Tactical Radio System. Case Studies in Software Radio Design: Introduction and Historical Perspective, SPEAK easy- JTRS, Wireless Information Transfer System, SDR-3000 Digital Transceiver Subsystem, Spectrum Ware, CHARIOT.

TEXT BOOKS:

1. Markus Dillinger, Kambiz Madani, **Software Defined Radio Architecture System and Functions,** WILEY 2003

2. Walter Tuttle Bee**, Software Defined Radio: Enabling Technologies**, Wiley Publications, 2002.

REFERENCE BOOKS:

1. Jeffrey H. Reed, **Software Radio: A Modern Approach to Radio Engineering**, PEA Publication , 2002.

2. Paul Burns, **Software Defined Radio for 3G ,** Artech House, 2002.

3. Markus Dillinger, Kambiz Madani, Nancy Alonistioti, **Software Defined Radio: Architectures, Systems and Functions,** Wiley , 2003.

4. Joseph Mitola, **Software Radio Architecture: Object Oriented Approaches to wireless System Engineering,** John Wiley & Sons ,III, 2000.

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Demonstrate what need of Software Radio is.
2. Manage the Radio Resources and Profiles

2015-16

Malla Reddy Engineering College (Autonomous)

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Course Code: 54124 **Credits: 4**

M.Tech. – II Semester

AD HOC WIRELESS NETWORKS

(Professional Elective -VI)

PREREQUISITES: Wireless Networks and Protocols

OBJECTIVE: To learn about Introduction, Fundamentals of WLANS,IEEE802.11 Standard, HIPERLAN Standard, Bluetooth and Home RF, To learn about Issues in Ad Hoc Wireless Networks, AD Hoc Wireless Internet.MAC Protocols for Ad Hoc Wireless Networks and Issues in designing a MAC protocol for Ad Hoc Wireless network, To learn about issues in designing a routing protocol for ad hoc wireless networks, classification of routing protocols, table-driven routing protocols on-demand routing protocols, hybrid routing protocols, routing protocols with efficient flooding mechanism, hierarchical; routing protocols, power-aware routing protocols.

Module – I : WIRELESS LANS AND PANS [8 Periods]

Introduction, Fundamentals of WLANS, IEEE802.11 Standard. HIPERLAN Standard, Bluetooth, Home RF. Wireless Internet: Wireless internet, mobile IP, TCP in Wireless Domain, WAP, Optimizing Web over Wireless.

Module – II : Ad hoc wireless networks [10 Periods] Introduction, Issues in Ad Hoc Wireless Networks, AD Hoc Wireless Internet.MAC Protocols for Ad Hoc Wireless Networks: Introduction, Issues in Designing a MAC protocol for Ad Hoc Wireless network, Design goals of MAC Protocol, contention - Based Protocols, contention -based protocol with Reservation Mechanism, contention - Based MAC Protocols with Scheduling Mechanisms, MAC protocol that use Directional Antenna, other MAC Protocol

Module – III: PROTOCOLS [10 Periods]

Routing: Introduction issues in designing a routing protocol for ad hoc wireless networks, classification of routing protocols, table-driven routing protocols, on-demand routing protocols, hybrid routing protocols, routing protocols with efficient flooding mechanism, hierarchical; routing protocols, power-aware routing protocols.

Transport layer and security protocols: introduction, issues in designing a transport layer protocol for ad hoc wireless networks, design goals of a transport layer protocol for ad hoc wireless networks, classification of transport layer solutions, TCP over ad hoc wireless networks, other transport layer protocol for ad hoc wireless networks, security provisioning, network security attacks, key management, secure routing in ad hoc wireless networks

Module - IV: QUALITY OF SERVICE [9 Periods]

Introduction, issues and Challenges in providing QoS in Ad Hoc Wireless Networks, Classification of QoS Solutions, MAC Layer solutions, Network layer solutions, QoS Frame Works for Ad Hoc Wireless Network**. Energy management**: Introduction, Need for Energy Management in Ad Hoc Wireless Networks, Classification of Ad Hoc Wireless networks, Battery Management Schemes, Transmission Power Management Schemes, System power management schemes.

Module - V: WIRELESS SENSOR NETWORKS [8 Periods]

Introduction, Sensor Network Architecture, Data Dissemination, Data Gathering, MAC Protocol for Sensor Networks, Location Discovery, Quality of Sensor Networks, Evolving Standards, Other Issues.

TEXT BOOKS:

1. C.Siva Ram Murthy and B.S.Manoj, **Ad HOC Wireless Networks: Architectures and protocols,** PHI,2004.
2. JagannathamSarangapani, Wireless **Ad-Hoc and Sensor Networks: Protocols, Performance and control** –CRC Press

REFERENCE BOOKS:

1. C.K.Toh, **Ad -Hoc Mobile Wireless Networks: Protocols And Systems,** Pearson Education,1ed.
2. C.S. Raghavendra, Krishna M.Sivalingam, **Wireless Sensor Networks,** 2004, Springer

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Learn about Introduction, Fundamentals of WLANS, IEEE802.11 Standard, HIPERLAN Standard, Bluetooth and Home RF.
2. Learn about Issues in Ad Hoc Wireless Networks, AD Hoc Wireless Internet.MAC Protocols for Ad Hoc Wireless Networks and Issues in designing a MAC protocol for Ad Hoc Wireless network.
3. Learn about issues in designing a routing protocol for ad hoc wireless networks, classification of routing protocols, table-driven routing protocols, on-demand routing protocols, hybrid routing protocols, routing protocols with efficient flooding mechanism, hierarchical; routing protocols, power-aware routing protocols.

2015-16

Malla Reddy Engineering College (Autonomous)

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4	-	-

Course Code: 54125 **Credits: 4**

M.Tech. – II Semester

SCRIPTING LANGUAGES

(Professional Elective -VI)

PREREQUISITES: Computer Languages.

OBJECTIVE: To learn about Characteristics and uses of scripting languages, Introduction to PERL, Names and values, Variables and assignment, Scalar expressions, Control structures, Built-in functions, Collections of Data and working with arrays , To learn about The TCL phenomena, Philosophy, Structure, Syntax, Parser, Variables and data in TCL, Control flow, Data structures, Simple input/output, Procedures, Working with Strings, Patterns, Files and Pipes , To learn about Objects, Classes, Encapsulation, Data Hierarchy.

Module - I: INTRODUCTION **[8 Periods]**

Characteristics and uses of scripting languages, Introduction to PERL, Names and values, Variables and assignment, Scalar expressions, Control structures, Built-in functions, Collections of Data, Working with arrays, Lists and hashes, Simple input and output, Strings, Patterns and regular expressions, Subroutines, Scripts with arguments.

Module - II: ADVANCED PERL **[8 Periods]**

Finger points of Looping, Subroutines, Using Pack and Unpack, Working with files, Navigating the file system, Type globs, Eval, References, Data structures, Packages, Libraries and modules, Objects, Objects and modules in action, Tied variables, Interfacing to the operating systems, Security issues.

Module - III: TCL **[7Periods]**

The TCL phenomena, Philosophy, Structure, Syntax, Parser, Variables and data in TCL, Control flow, Data structures, Simple input/output, Procedures, Working with Strings, Patterns, Files and Pipes, Example code.

Module - IV: ADVANCED TCL **[9Periods]**

The eval, source, exec and up-level commands, Libraries and packages, Namespaces, Trapping errors, Event-driven programs, Making applications 'Internet-aware', 'Nuts-and-bolts' internet programming, Security issues, running untrusted code, The C interface.

Module - V: TK AND JAVASCRIPT **[10 Periods]**

Visual tool kits, Fundamental concepts of TK, TK by example, Events and bindings, Geometry managers, PERL-TK. Java Script – Object models, Design Philosophy, Versions of JavaScript, The Java Script core language, Basic concepts of Python.

Object Oriented Programming Concepts (Qualitative Concepts Only): Objects, Classes, Encapsulation, Data Hierarchy.

TEXT BOOKS:

1. David Barron**, The World of Scripting Languages,** Wiley Student Edition, 2010.
2. Ken Jones and Jeff Hobbs. **Practical Programming in Tcl and Tk - Brent Welch**,Fourth edition.
3. Herbert Schildt, **Java the Complete Reference,** TMH,7th Edition.

REFERENCE BOOKS:

1. ClifFlynt, TCL/**TK: A Developer's Guide ,**Morgan Kaufmann SerieS , 2003.
2. **Tcl and the TK Toolkit- John Ousterhout**, Kindel Edition , 2nd Edition, 2009.
3. WojciechKocjan and PiotrBeltowski,**Tcl 8.5 Network Programming book,** Packt Publishing.
4. Bert Wheeler, **Tcl/Tk 8.5 Programming Cookbook.**

COURSE OUTCOMES:

After completion of the course, students will be able to:

1. Learn about Characteristics and uses of scripting languages, Introduction to PERL, Names and values, Variables and assignment, Scalar expressions, Control structures, Built-in functions, Collections of Data and working with arrays.
2. Learn about The TCL phenomena, Philosophy, Structure, Syntax, Parser, Variables and data in TCL, Control flow, Data structures, Simple input/output, Procedures, Working with Strings, Patterns, Files and Pipes.
3. Learn about Objects, Classes, Encapsulation, Data Hierarchy.

2015-16

Malla Reddy Engineering College (Autonomous)

L	T	P
-	-	4

Course Code: 54126 **Credits: 2**

M.Tech. – II Semester

Embedded System Lab

Note: The following programs are to be Implement on 89C51 Development board using Embedded C Language on Keil IDE and Flash magic.

List of experiments:

1. Program to toggle all the bits of Port P1 continuously with 250 mS delay.
2. Program to toggle only the bit P1.5 continuously with some delay. Use Timer 0, mode 1 to create delay.
3. Program to interface a switch and a buzzer to two different pins of a Port such that the buzzer should sound as long as the switch is pressed.
4. Program to interface LCD data pins to port P1 and display a message on it.
5. Program to interface keypad. Whenever a key is pressed, it should be displayed on LCD.
6. Program to interface seven segment display unit.
7. Program to transmit a message from Microcontroller to PC serially using RS232.
8. Program to receive a message from PC serially using RS232.
9. Program to get analog input from Temperature sensor and display the temperature value on PC Monitor.
10. Program to interface Stepper Motor to rotate the motor in clockwise and anticlockwise directions.
11. Program to interfacing RFID.
12. Implementation of Traffic light controller.

2015-16

Malla Reddy Engineering College (Autonomous)

L T P
- - 4

Course Code: 54127 **Credits: 2**

M.Tech. – II Semester
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2015-16

Malla Reddy Engineering College (Autonomous)

L T P
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Course Code: 54128 **Credits: 4**

M.Tech. – III Semester
Comprehensive Viva - voce

2015-16

Malla Reddy Engineering College (Autonomous)

L T P
- - 16

Course Code: 54129 **Credits: 8**

M.Tech. – III Semester
Project Work Part I

2015-16

Malla Reddy Engineering College (Autonomous)

L T P
- - 16

Course Code: 54130 **Credits: 8**

M.Tech. – IV Semester
Project Work Part II

2015-16

Malla Reddy Engineering College (Autonomous)

L T P
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Course Code: 54131 **Credits: 12**

M.Tech. – IV Semester
Project Viva – Voce